LZ2 Block Diagram

Project code: 91.4K101.001 ZY LZ2
91.4J301.001 XR LX2
PCB P/N : 07260-SB
Revision : SA

CLK GEN. 3

Mobile CPU
Penryn SV 35W
4, 5

EMC2102 07

HOST BUS 800/1066MHz@1.05V

DDR3 socket 15 — 800/1066MHz

DDR3 socket 16 — 800/1066MHz

Cantiga 8,9,10,11,12,13,14
AGTL+ CPU I/F
DDR Memory I/F
INTEGRATED GRAHPICS
LVDS, CRT I/F

R.G.B → CRT 18

LVDS → 12"W LCD 17

X4 DMI 400MHz

C-Link0

ICH9M 19,20,21,22,23
6 PCIe ports
PCI/PCI BRIDGE
ACPI 1.1
4 SATA
12 USB
High Definition Audio
LPC I/F
Serial Peripheral I/F

INT MIC
SPR x2
Codec ALC269 (include AMP) 25
AZALIA

MIC In
HP

RJ11
MODEM MDC Card 24

USB → Realtek RTS5158E Cardreader 28 → SD/MMC/MS 3 in 1 28

PCIe → LAN Boardcom 5906M 26 → RJ45 27

PCIe/ USB → Mini Card a/b/g/n 31

LPC BUS → KBC Winbond WPC776 29 (SPI I/F → BIOS 2M byte 34)
→ LPC DEBUG CONN. 24
→ G-sensor 30
→ Touch Pad 34
→ INT. KB 34

New card 31 — PCI Express / USB

Power switch 31

SATA → SATA-HDD 24

SATA → SATA-ODD 24

USB → Finger Print 32
→ BlueTooth 24
→ CAMERA 17
→ USB 3 Port 32

PCB 8-LAYER STACKUP

TOP
GND
S
S
PWR
S
GND
BOTTOM

SYSTEM DC/DC TPS51120 36	
INPUTS	OUTPUTS
DCBATOUT	5V_S5 3D3V_S5

SYSTEM DC/DC TPS51124 37	
INPUTS	OUTPUTS
DCBATOUT	1D05V_S0 1D5V_S3

TPS51100 38	
1D5V_S3	DDR_VREF_S0 (1.5A) DDR_VREF_S3

33	
1D5V_S3	1D5V_S0

CHARGER BQ24740 39	
INPUTS	OUTPUTS
DCBATOUT	CHG_PWR 18V UP+5V 5V 100mA

CPU DC/DC ADP3208 35	
INPUTS	OUTPUTS
DCBATOUT	VCC_CORE

ICH9M Functional Strap Definitions

ICH9 EDS 642879 Rev.1.5

Signal	Usage/When Sampled	Comment
HDA_SDOUT	XOR Chain Entrance/ PCIE Port Config1 bit1, Rising Edge of PWROK	Allows entrance to XOR Chain testing when TP3 pulled low.When TP3 not pulled low at rising edge of PWROK,sets bit1 of RPC.PC(Config Registers: offset 224h). This signal has weak internal pull-down
HDA_SYNC	PCIE config1 bit0, Rising Edge of PWROK.	This signal has a weak internal pull-down. Sets bit0 of RPC.PC(Config Registers:Offset 224h)
GNT2#/ GPIO53	PCIE config2 bit2, Rising Edge of PWROK.	This signal has a weak internal pull-up. Sets bit2 of RPC.PC2(Config Registers:Offset 0224h)
GPIO20	Reserved Rising Edge of PWROK.	This signal has a weak internal pull-down. Note:This signal should not be pulled high.
GNT1#/ GPIO51	ESI Strap(Server Only) Rising edge of PWROK	Tying this strap low configures DMI for SIcompatible operation. This signal has a weak internal pull-up. NOTE: ESI compatible mode is for server latforms only. This signal should not be pulled low for desktop and mobile.
GNT3#/ GPIO55	Top-Block Swap Override. Rising Edge of PWROK.	Sampled low:Top-Block Swap mode(inverts A16 for all cycles targeting FWH BIOS space). Note: Software will not be able to clear the Top-Swap bit until the system is rebooted without GNT3# being pulled down.
GNT0#: SPI_CS1#/ GPIO58	Boot BIOS Destination Selection 0:1. Rising Edge of PWROK.	Controllable via Boot BIOS Destination bit (Config Registers:Offset 3410h:bit 11:10). GNT0# is MSB, 01-SPI, 10-PCI, 11-LPC.
SPI_MOSI	Integrated TPM Enable, Rising Edge of CLPWROK	Sample low: the Integrated TPM will be disabled. Sample high: the MCH TPM enable strap is sampled low and the TPM Disable bit is clear, the Integrated TPM will be enable.
GPIO49	DMI Termination Voltage, Rising Edge of PWROK.	The signal is required to be low for desktop applications and required to be high for mobile applications.
SATALED#	PCI Express Lane Reversal. Rising Edge of PWROK.	Signal has weak internal pull-up. Sets bit 27 of MPC.LR(Device 28:Function 0:Offset D8)
SPKR	No Reboot. Rising Edge of PWROK.	If sampled high, the system is strapped to the "No Reboot" mode(ICH9 will disable the TCO Timer system reboot feature). The status is readable via the NO REBOOT bit.
TP3	XOR Chain Entrance. Rising Edge of PWROK.	This signal should not be pull low unless using XOR Chain testing.
GPIO33/ HDA_DOCK _EN#	Flash Descriptor Security Override Strap Rising Edge of PWROK	Sampled low:the Flash Descriptor Security will be overridden. If high,the security measures will be in effect.This should only be enabled in manufacturing environments using an external pull-up resister.

ICH9M Integrated Pull-up and Pull-down Resistors

ICH9 EDS 642879 Rev.1.5

SIGNAL	Resistor Type/Value
CL_CLK[1:0]	PULL-UP 20K
CL_DATA[1:0]	PULL-UP 20K
CL_RST0#	PULL-UP 20K
DPRSLPVR/GPIO16	PULL-DOWN 20K
ENERGY_DETECT	PULL-UP 20K
HDA_BIT_CLK	PULL-DOWN 20K
HDA_DOCK_EN#/GPIO33	PULL-UP 20K
HDA_RST#	PULL-DOWN 20K
HDA_SDIN[3:0]	PULL-DOWN 20K
HDA_SDOUT	PULL-DOWN 20K
HDA_SYNC	PULL-DOWN 20K
GLAN_DOCK#	The pull-up or pull-down active when configured for native GLAN_DOCK# functionality and determined by LAN controller
GNT[3:0]#/GPIO[55,53,51]	PULL-UP 20K
GPIO[20]	PULL-DOWN 20K
GPIO[49]	PULL-UP 20K
LDA[3:0]#/FHW[3:0]#	PULL-UP 20K
LAN_RXD[2:0]	PULL-UP 20K
LDRQ[0]	PULL-UP 20K
LDRQ[1]/GPIO23	PULL-UP 20K
PME#	PULL-UP 20K
PWRBTN#	PULL-UP 20K
SATALED#	PULL-UP 15K
SPI_CS1#/GPIO58/CLGPIO6	PULL-UP 20K
SPI_MOSI	PULL-DOWN 20K
SPI_MISO	PULL-UP 20K
SPKR	PULL-DOWN 20K
TACH_[3:0]	PULL-UP 20K
TP[3]	PULL-UP 20K
USB[11:0][P,N]	PULL-DOWN 15K

Cantiga chipset and ICH9M I/O controller Hub strapping configuration

Montevina Platform Design guide 22339 0.5
page 218

Pin Name	Strap Description	Configuration
CFG[2:0]	FSB Frequency Select	000 = FSB1067 011 = FSB667 010 = FSB800 others = Reserved
CFG[4:3] CFG8 CFG11 CFG[15:14] CFG[18:17]	Reserved	
CFG5	DMI x2 Select	0 = DMI x2 **1 = DMI x4 (Default)**
CFG6	iTPM Host Interface	0= The iTPM Host Interface is enabled(Note2) **1= The iTPM Host Interface is disalbed(default)**
CFG7	Intel Management engine Crypto strap	0 = Transport Layer Security (TLS) cipher suite with no confidentiality **1 = TLS cipher suite with confidentiality (default)**
CFG9	PCIE Graphics Lane	0 = Reverse Lanes,15->0,14->1 ect.. **1= Normal operation(Default):Lane Numbered in order**
CFG10	PCIE Loopback enable	0 = Enable (Note 3) **1= Disabled (default)**
CFG[13:12]	XOR/ALL	00 = Reserve 10 = XOR mode Enabled 01 = ALLZ mode Enabled (Note 3) **11 = Disabled (default)**
CFG16	FSB Dynamic ODT	0 = Dynamic ODT Disabled **1 = Dynamic ODT Enabled (Default)**
CFG19	DMI Lane Reversal	**0 = Normal operation(Default): Lane Numbered in Order** 1 = Reverse Lanes DMI x4 mode[MCH -> ICH]:(3->0,2->1,1->2and0->3) DMI x2 mode[MCH -> ICH]:(3->0,2->1)
CFG20	Digital Display Port (SDVO/DP/iHDMI) Concurrent with PCIe	**0 = Only Digital Display Port or PCIE is operational (Default)** 1 =Digital display Port and PCIe are operting simulataneously via the PEG port
SDVO_CTRLDATA	SDVO Present	**0 = No SDVO Card Present (Default)** 1 = SDVO Card Present
L_DDC_DATA	Local Flat Panel (LFP) Present	**0 = LFP Disabled (Default)** 1= LFP Card Present; PCIE disabled

NOTE:
1. All strap signals are sampled with respect to the leading edge of the (G)MCH Power OK (PWROK) signal.
2. iTPM can be disabled by a 'Soft-Strap' option in the Flash-decriptor section of the Firmware. This 'Soft-Strap' is activated only after enabling iTPM via CFG6.
Only one of the CFG10/CFG/12/CFG13 straps can be enabled at any time.

PCIE Routing

LANE1	BroadCom LAN
LANE2	MiniCard WLAN
LANE4	NewCard

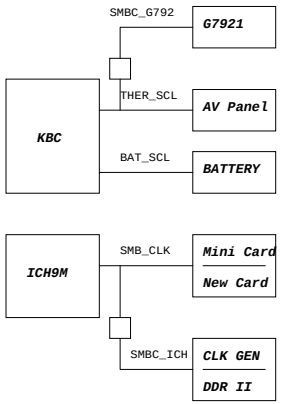
History:

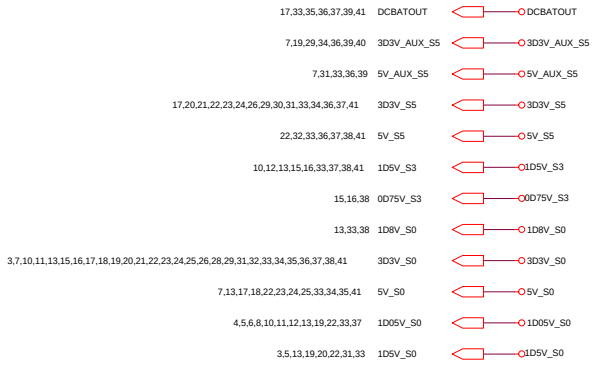
LAB: 2008/01/02

USB Table

USB	
Pair	Device
0	JACK0
1	NC
2	JACK2
3	NC
4	BLUETOOTH
5	JACK1
6	Fringer Print
7	Mini Card
8	CAMERA
9	NEW CARD
10	CARDREADER
11	NC

SMBus





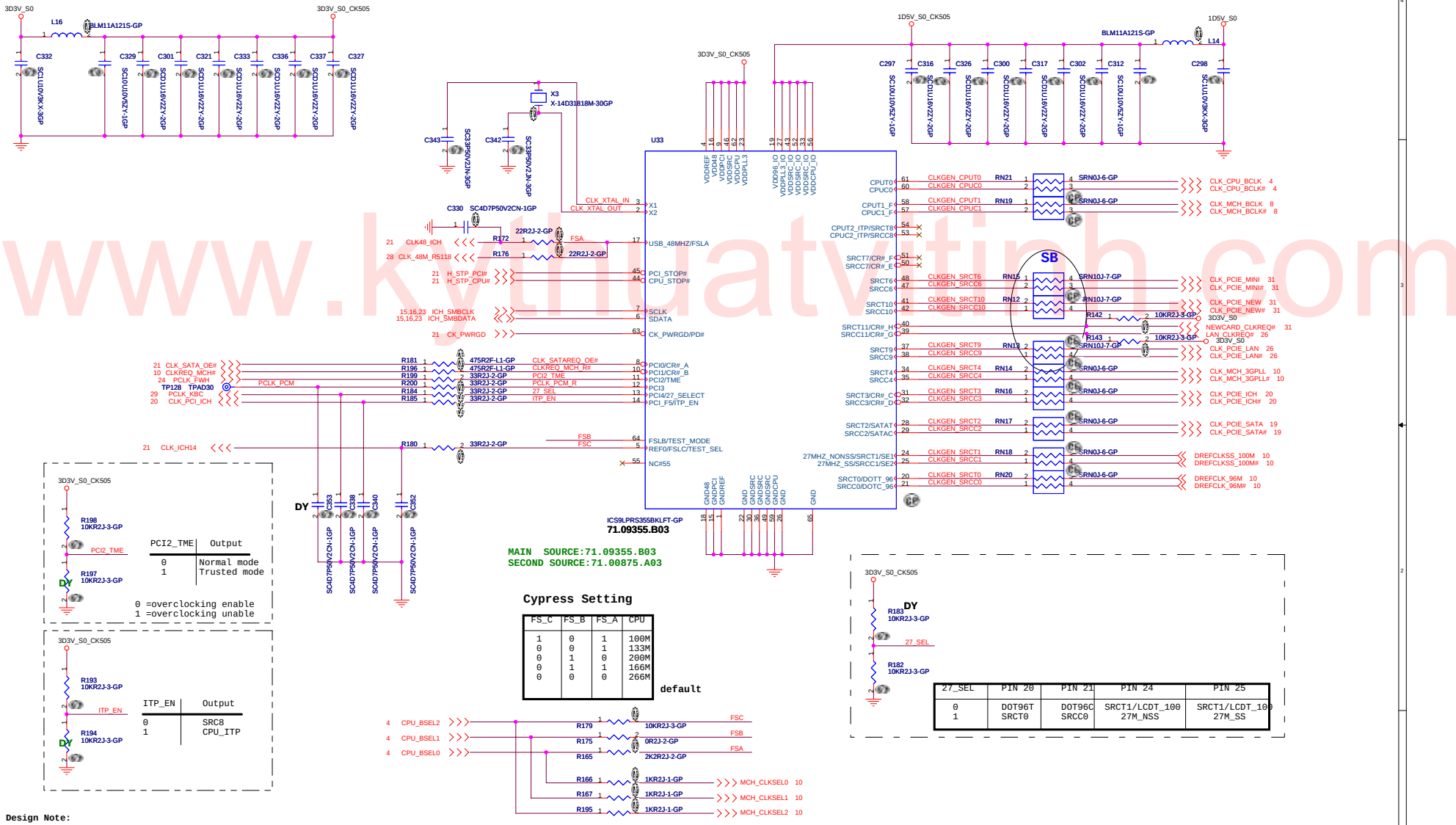
<Variant Name>

Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

Title: Reference

Size	Document Number	Rev
C	LZ2	SB

Date: Wednesday, April 16, 2008 Sheet 2 of 41



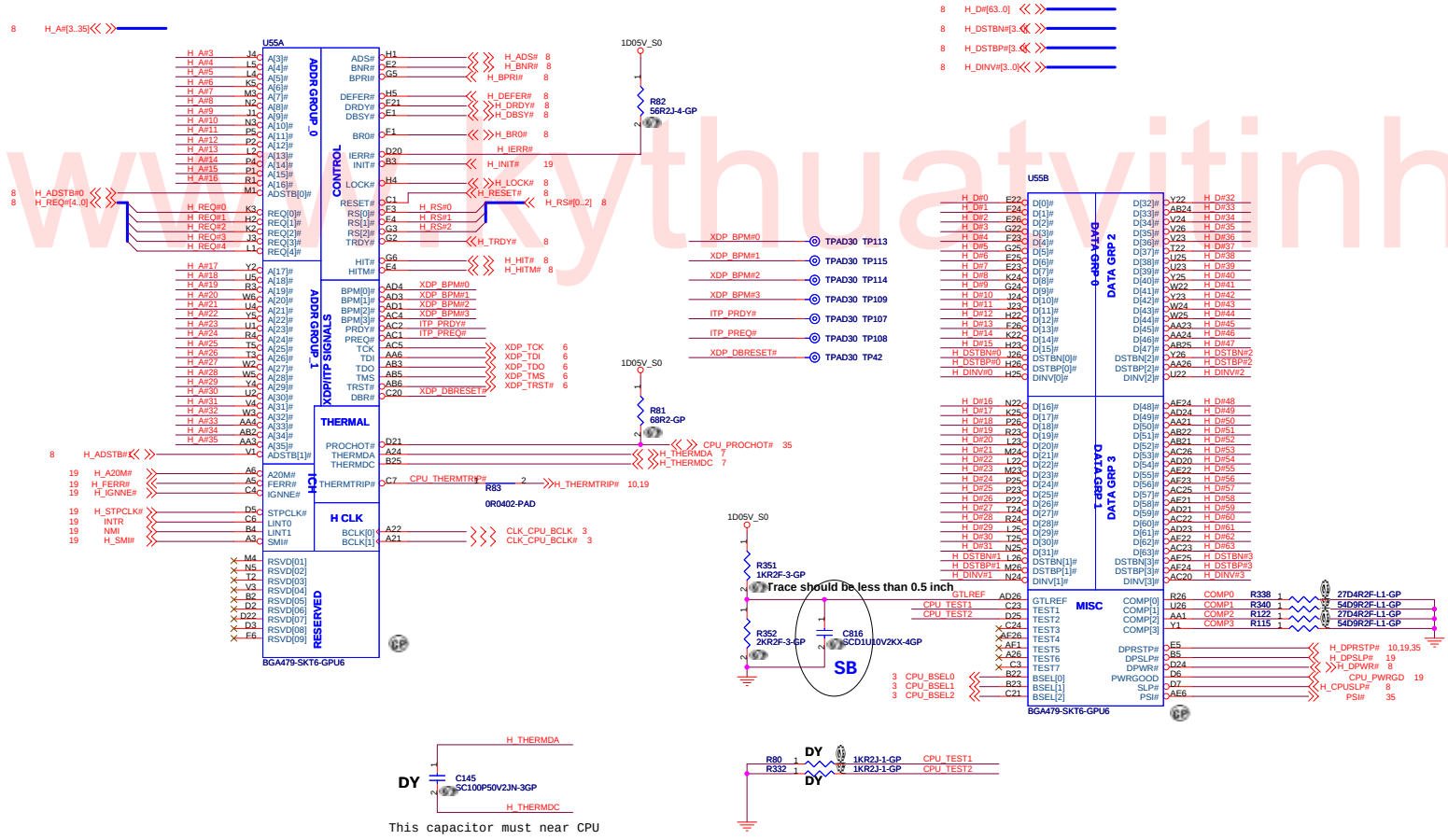
<Variant Name>

Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

Title: Clock Generator

Size	Document Number	Rev
	LZ2	SB

Date: Wednesday, April 16, 2008 Sheet 3 of 41



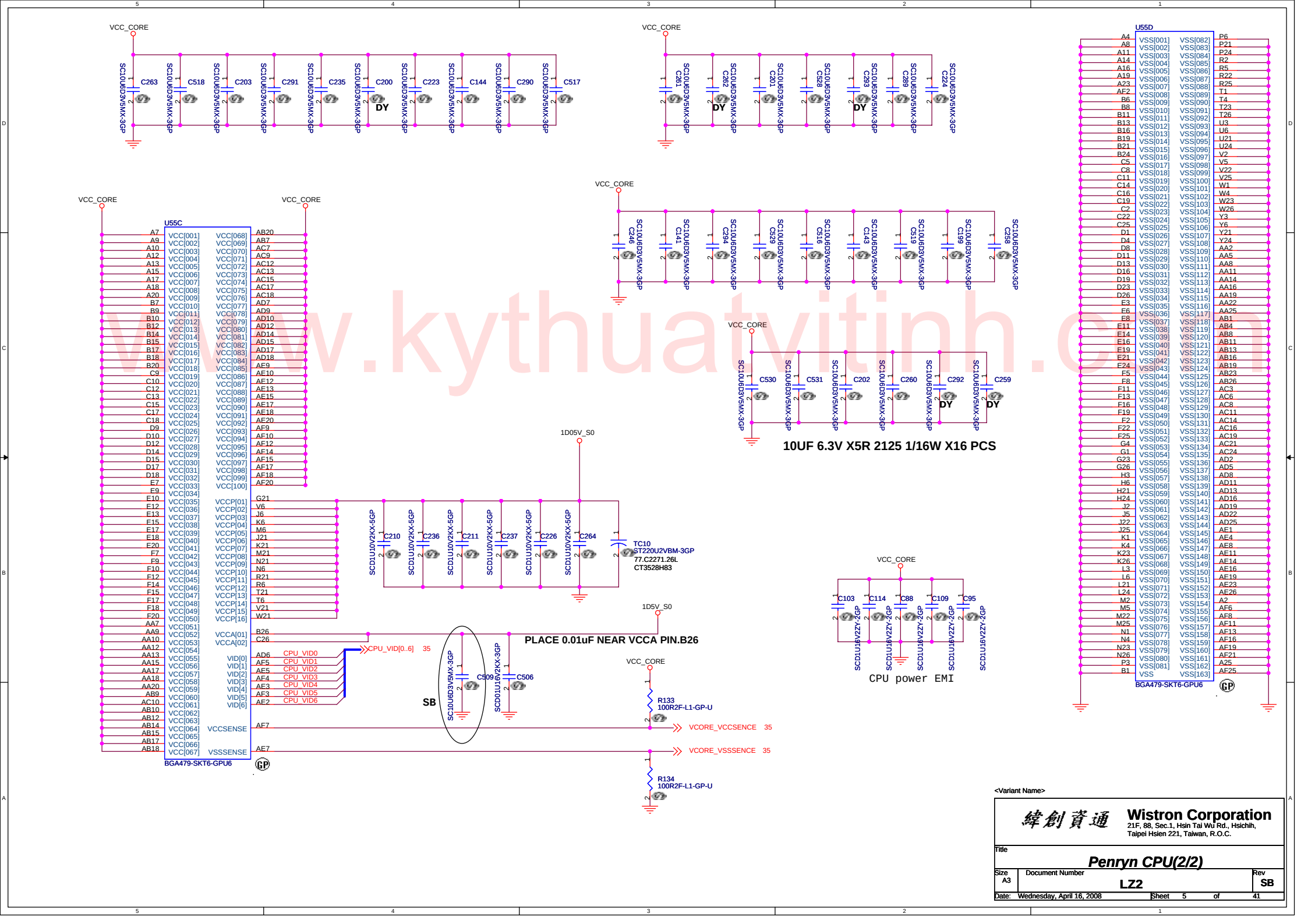
<Variant Name>

Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

Title: Penryn CPU(1/2)

Size	Document Number	Rev
C	LZ2	SB

Date: Wednesday, April 16, 2008 Sheet 4 of 41



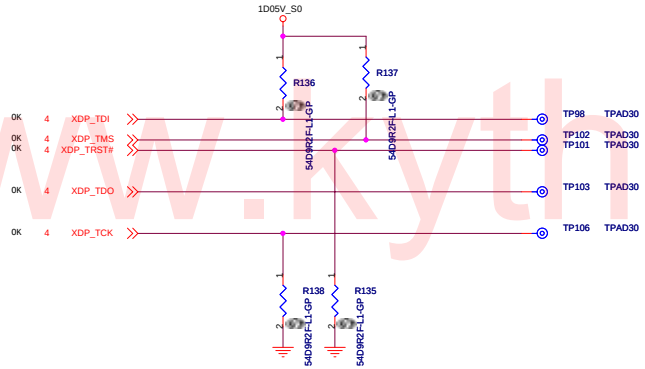
<Variant Name>

Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

Title: Penryn CPU(2/2)

Size: A3 | Document Number: LZ2 | Rev: SB

Date: Wednesday, April 16, 2008 | Sheet 5 of 41



<Variant Name>

鋒創資通 Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

Title: ITP CONN

Size: C | Document Number: LZ2 | Rev: SB

Date: Wednesday, April 16, 2008 | Sheet 6 of 41

Layout notice :
Both H_THERMDA and THERMDC routing
10 mil trace width and 10 mil spacing

Layout notice :
Both H_THERMDA_1 and THERMDC_1 routing
10 mil trace width and 10 mil spacing

Layout notice : Both DN3 and DP3 routing
10 mil trace width and 10 mil spacing

Layout notice :
C809, C811, C812
close to chip side;

CPU0

SYSTEM

This cap should close to thermal diode.

EMC2102

EMC2102-DZK-GP
74.02102.A73

Layout 15 mil

GND = Fan is OFF
OPEN = Fan is at 60% full-scale
+3.3V = Fan is at 75% full-scale

GND = Internal Oscillator Selected
+3.3V = External 32.768kHz Clock Selected

TRIP_SET Pin Voltage
V_DEGREE
=(((Degree-75)/21)

SC

U96
NC7SZ08P5-GP
73.7SZ08.AAH
220ms delay time after Power-on

Dummy when G792 enhanced T8 function

HW thermal shut down tempature
setting 95 degree . Put Near CPU .

U28
G709T1UF-GP

Rset=0.0012*T^2-0.9308*T+96.147

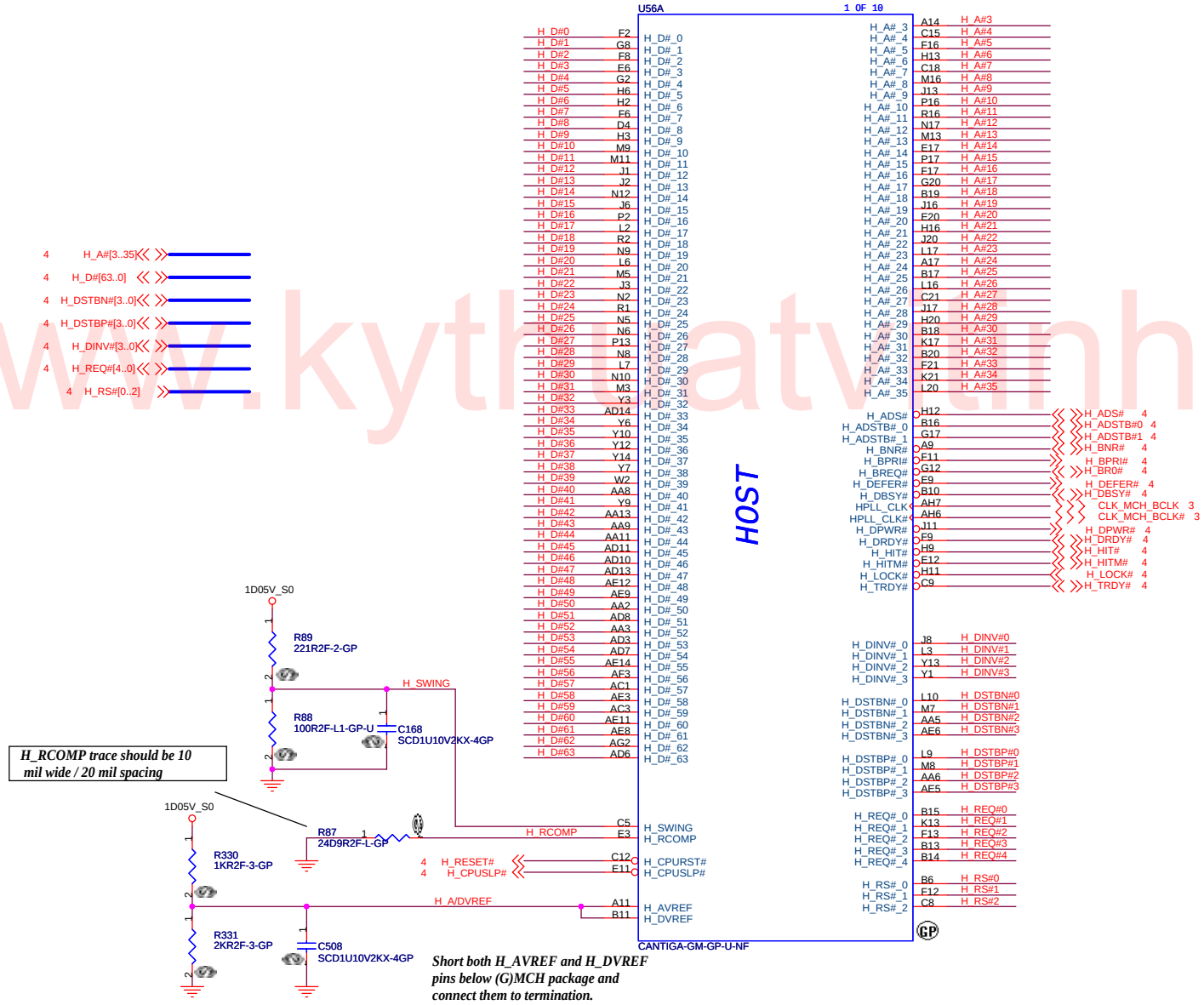
BOM1

Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

Title: Thermal/Fan Controllor EMC2102

Size: Custom | Document Number: LZ2 | Rev: SB

Date: Wednesday, April 16, 2008 | Sheet 7 of 41



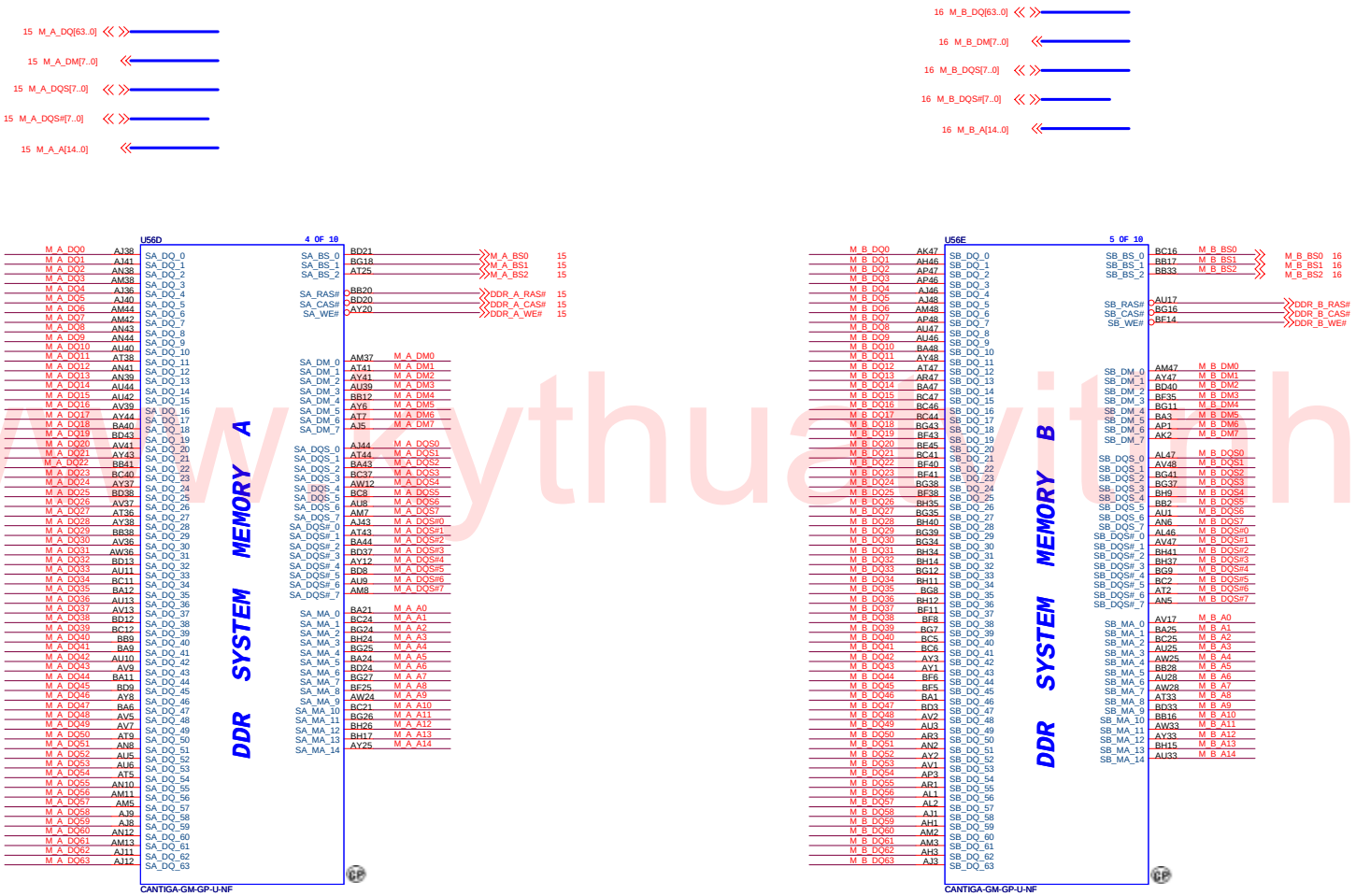
<Variant Name>

緯創資通 Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

Title: Cantiga(1/7):HOST I/F

Size	Document Number	Rev
A3	LZ2	SB

Date: Wednesday, April 16, 2008 Sheet 8 of 41



<variant_name>

蜂創資通	Wistron Corporation 21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih, Taipei Hsien 221, Taiwan, R.O.C.		
Title	Cantiga(2/7):DDR3		
Size C	Document Number LZ2		Rev SB
Date: Wednesday, April 16, 2008	Sheet 9	of	41

ME DEBUG PORT PIN OUT TABLE

RESERVED#AL34	ME_JTAG_TCK
RESERVED#AK34	ME_JTAG_TDI
RESERVED#AN35	ME_JTAG_TDO
RESERVED#AM35	ME_JTAG_TMS

CFG5 : DMIx2
CFG6 : iTPM
CFG7 : ME Crypto
CFG9: PCIE STD& REV
CFG16 : FSB Dynamic ODT
CFG19 : DMI Lane reversal
CFG20 : DP concurrent
CFG[17:3]:internal pullup
CFG[20:18]:internal pulldown

SM_REXT:Constant circuit reference for clocks.

INTEL Suggest use 511

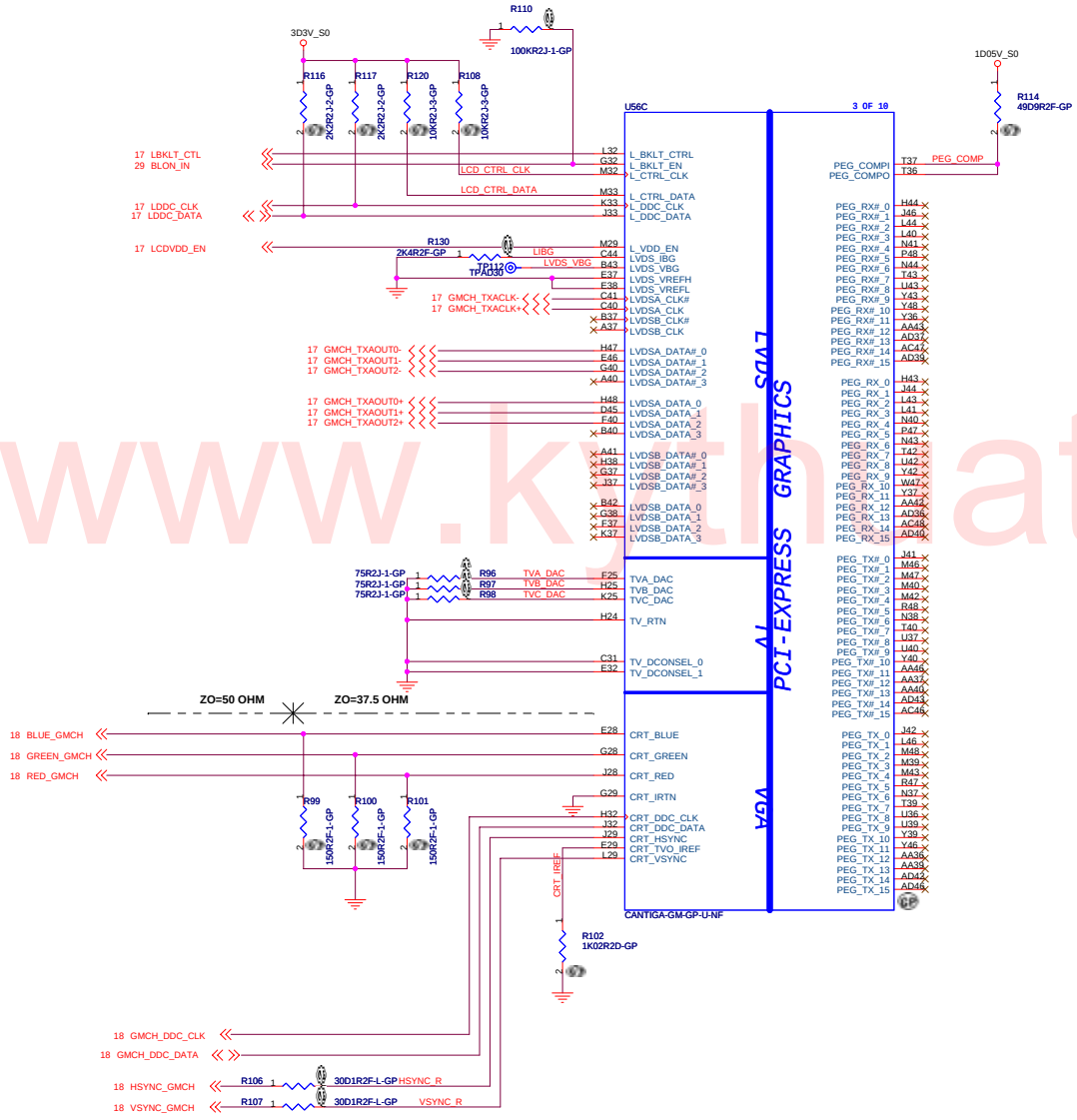
Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

<Variant Name>

Title: Cantiga(3/7):DMI/PM/CFG/GF

Size: C | Document Number: LZ2 | Rev: SB

Date: Wednesday, April 16, 2008 | Sheet 10 of 41



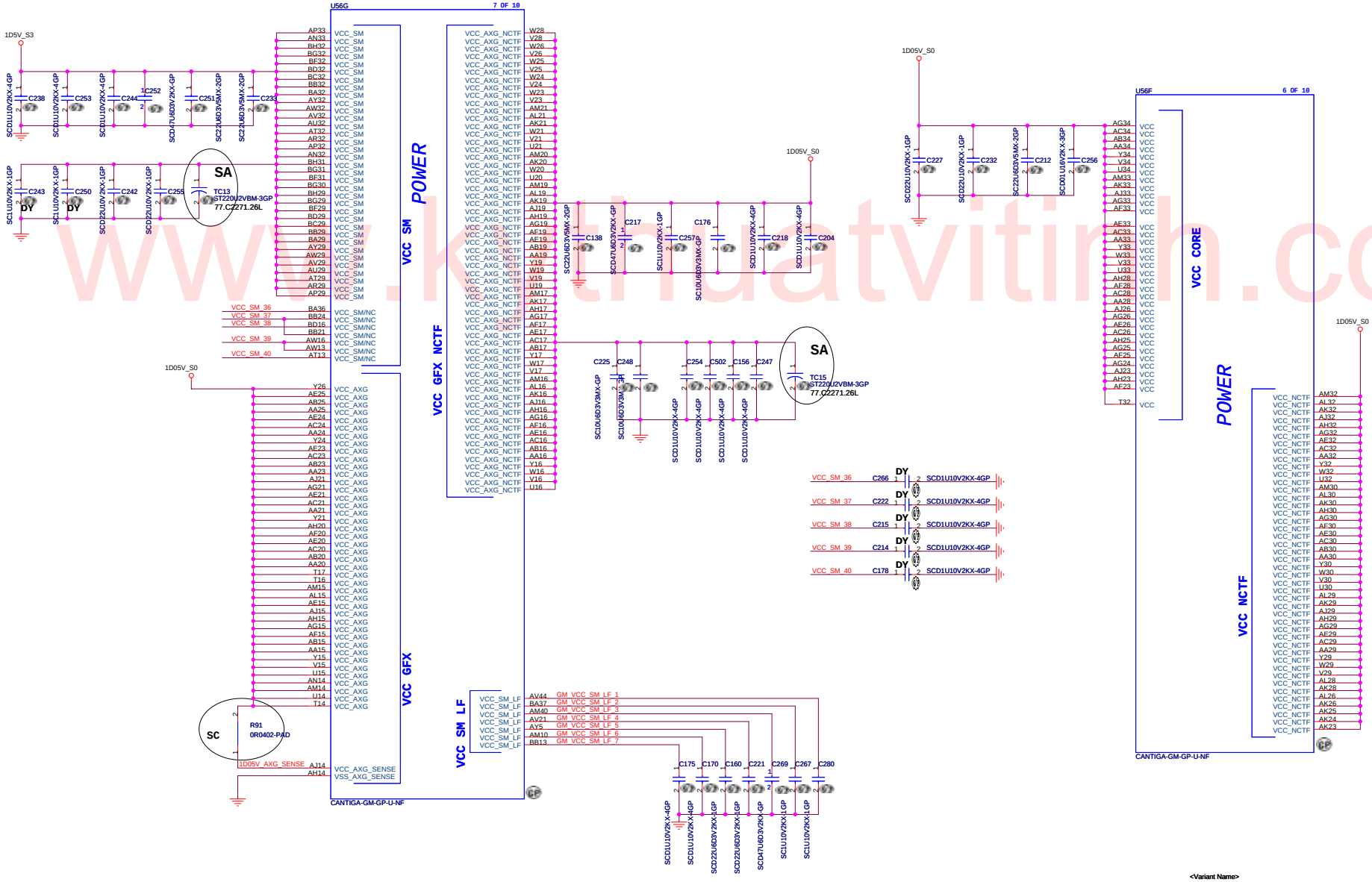
<Variant Name>

Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

Title: CANTIGA(5/7)-VGA/LVDS

Size	Document Number	Rev
C	LZ2	SB

Date: Wednesday, April 16, 2008 Sheet 11 of 41



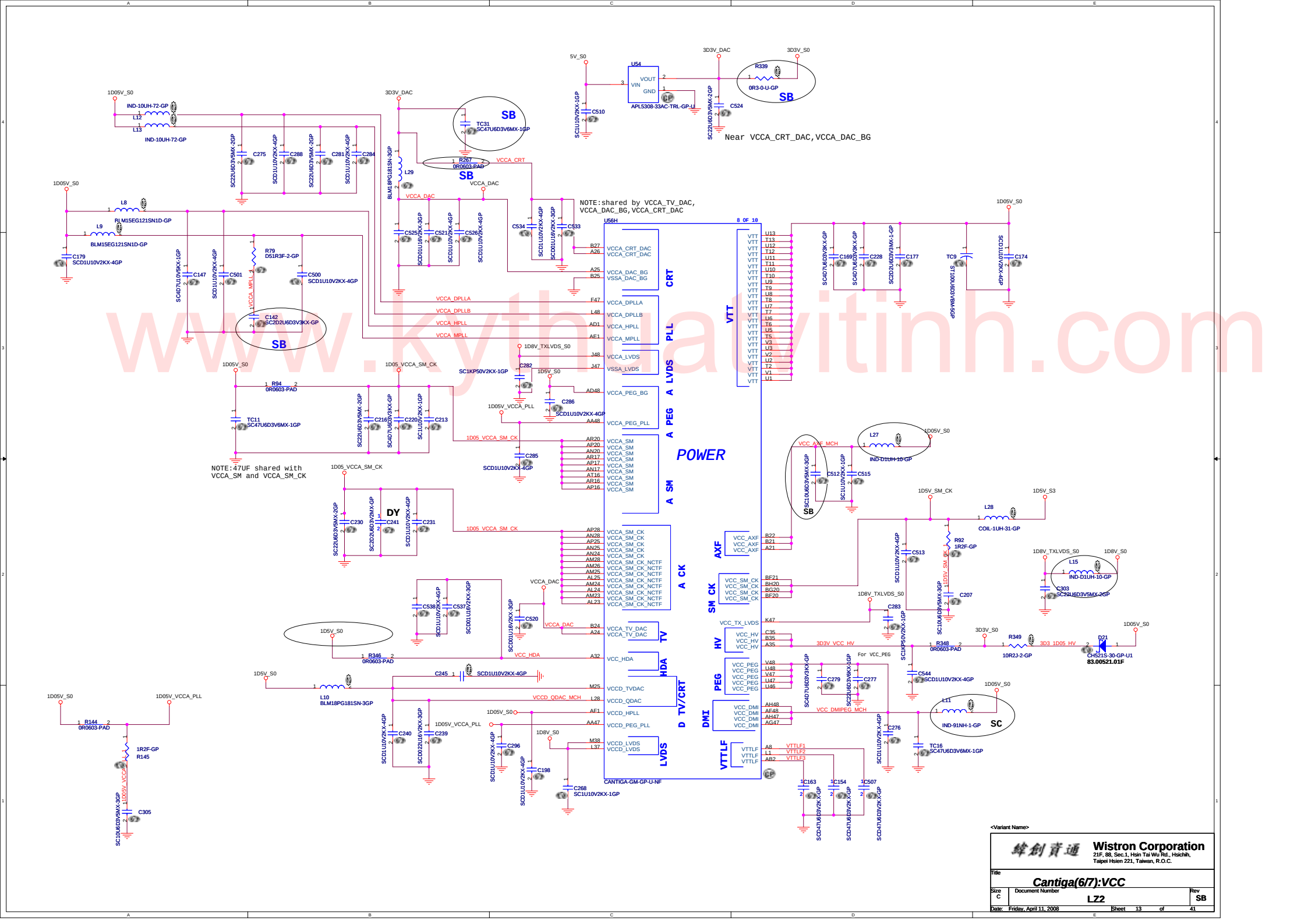
<Variant Name>

Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

Title: Cantiga(5/7):VCC

Size	Document Number	Rev
C	LZ2	SB

Date: Friday, April 11, 2008 Sheet 12 of 41



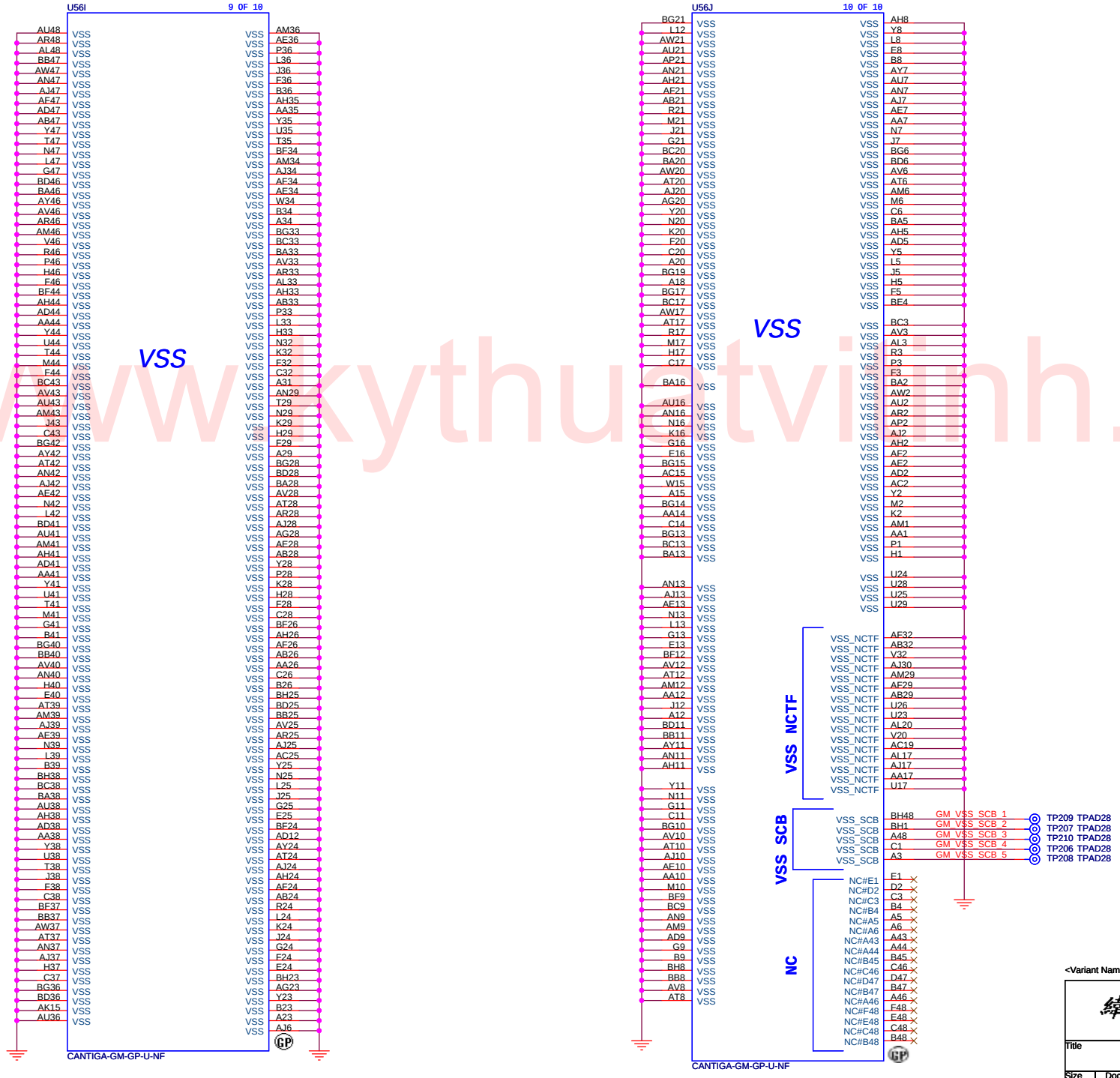
Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

<variant_name>

Title: Cantiga(6/7):VCC

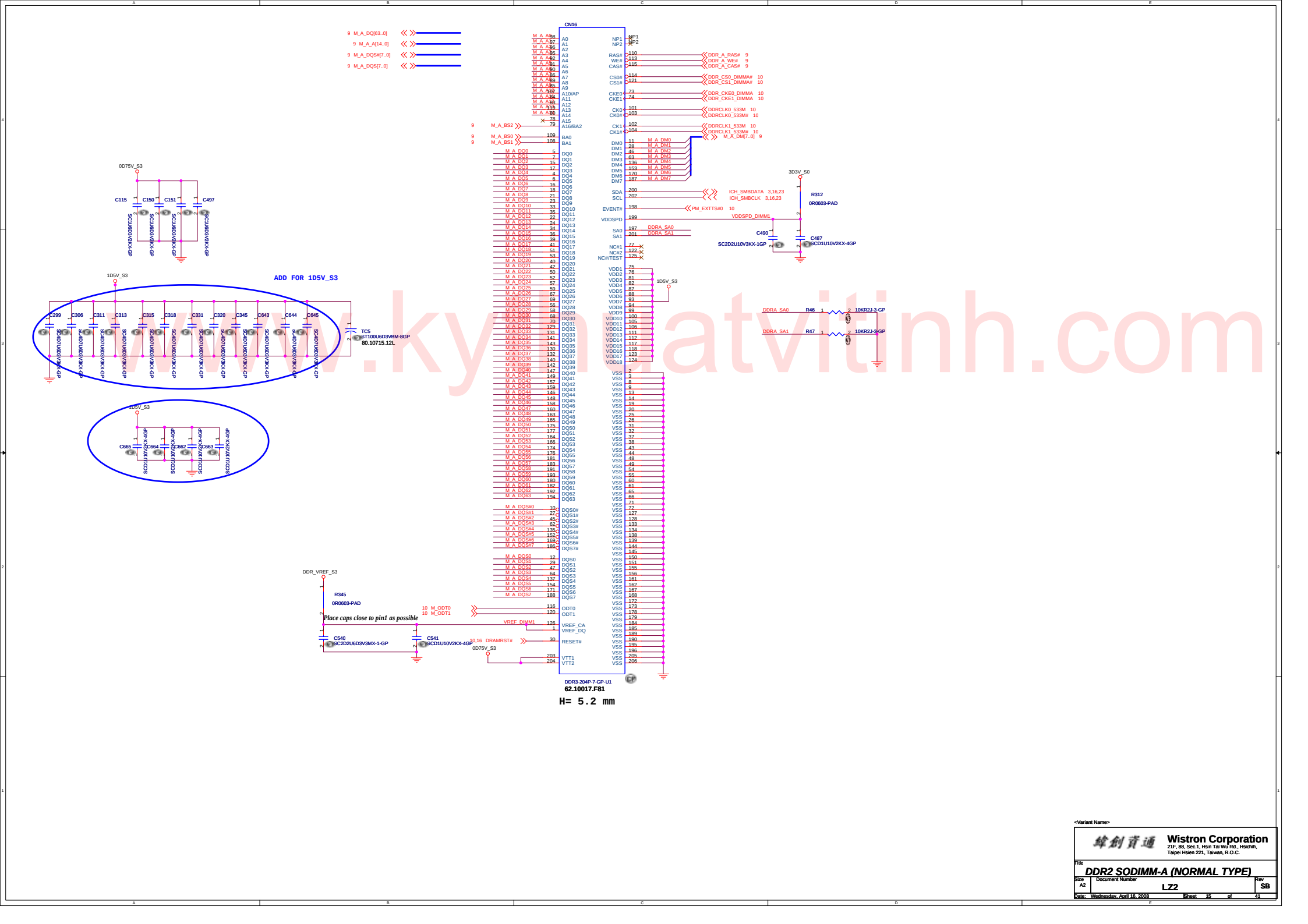
Size: C | Document Number: LZ2 | Rev: SB

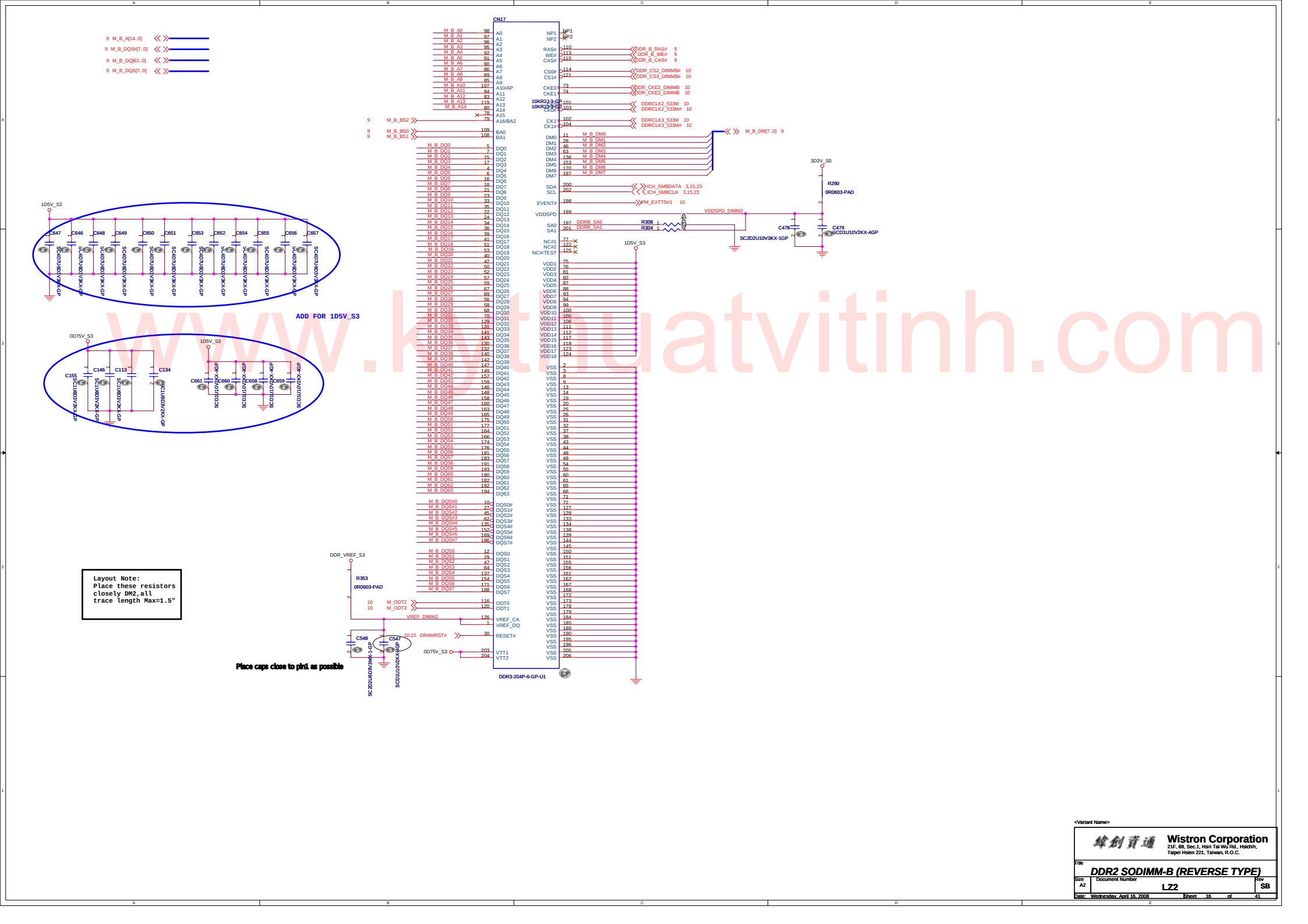
Date: Friday, April 11, 2008 | Sheet 13 of 41



<Variant Name>

緯創資通	Wistron Corporation 21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih, Taipei Hsien 221, Taiwan, R.O.C.	
Title	Cantiga(8/7):GND	
Size A3	Document Number LZ2	Rev SB
Date: Wednesday, April 09, 2008	Sheet 14 of 41	





<Variant Name>

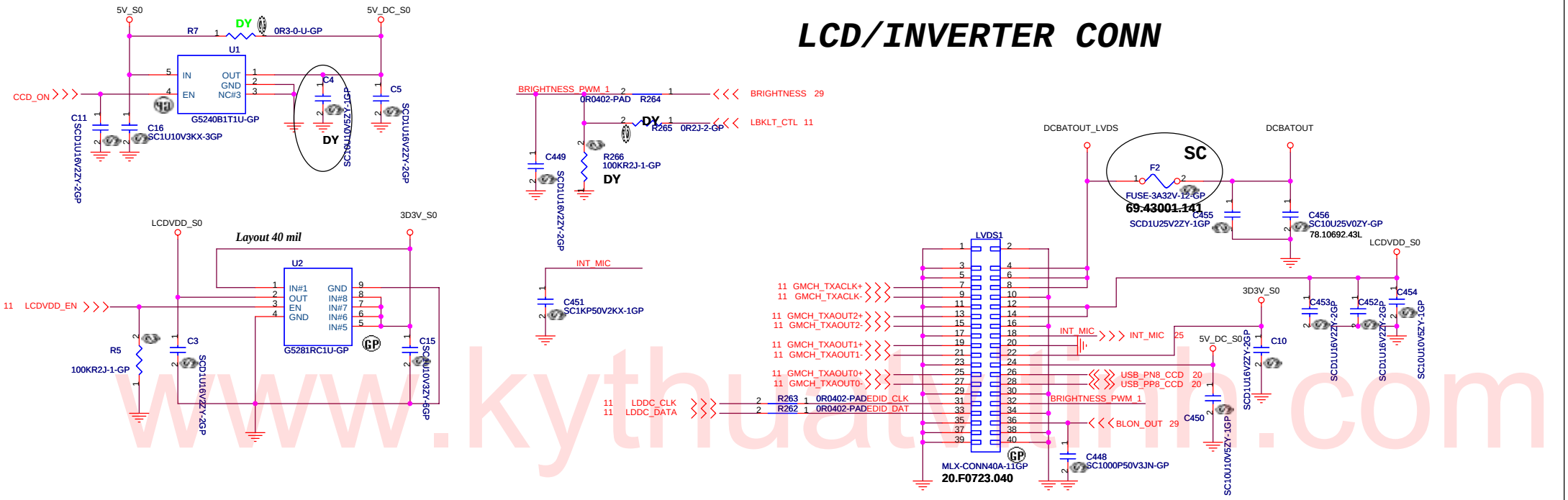
Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

Title: DDR2 SODIMM-B (REVERSE TYPE)

Size: A2 | Document Number: LZ2 | Rev: SB

Date: Wednesday, April 16, 2008 | Sheet 16 of 41

LCD/INVERTER CONN

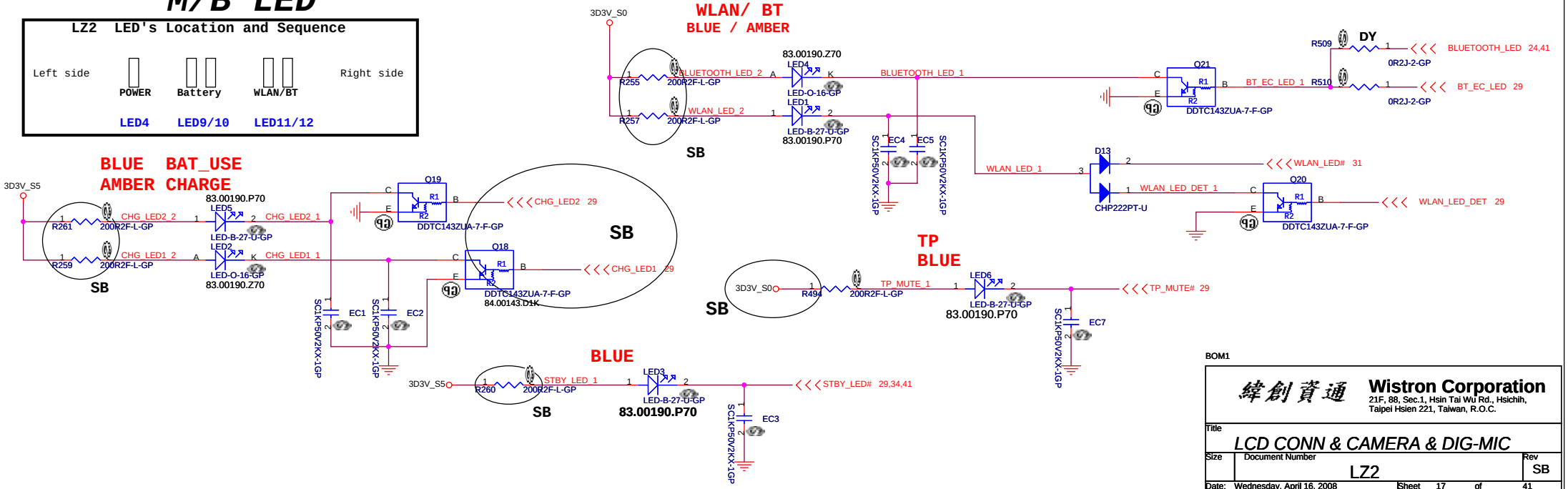


M/B LED

LZ2 LED's Location and Sequence

Left side — POWER — Battery — WLAN/BT — Right side

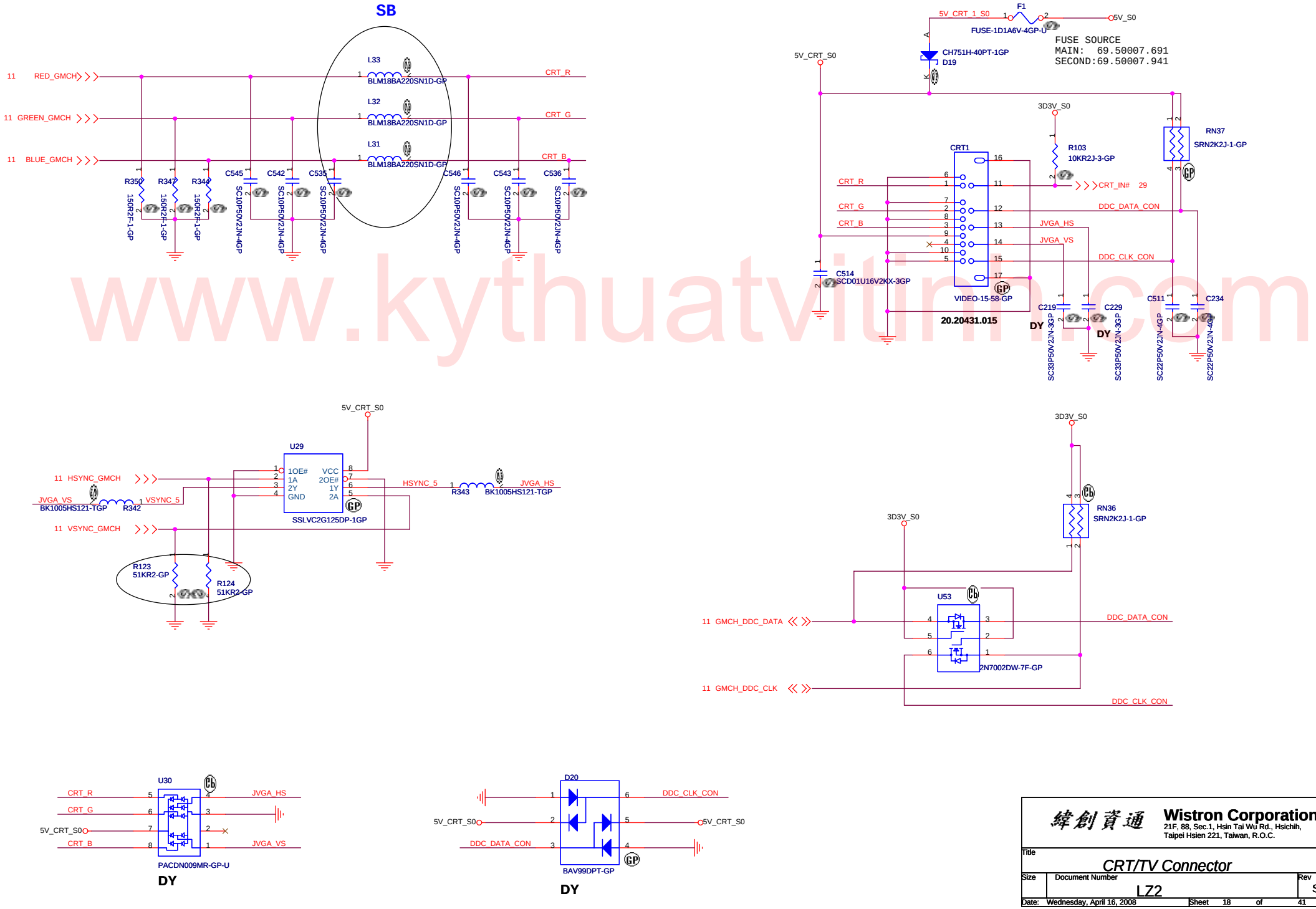
LED4 LED9/10 LED11/12



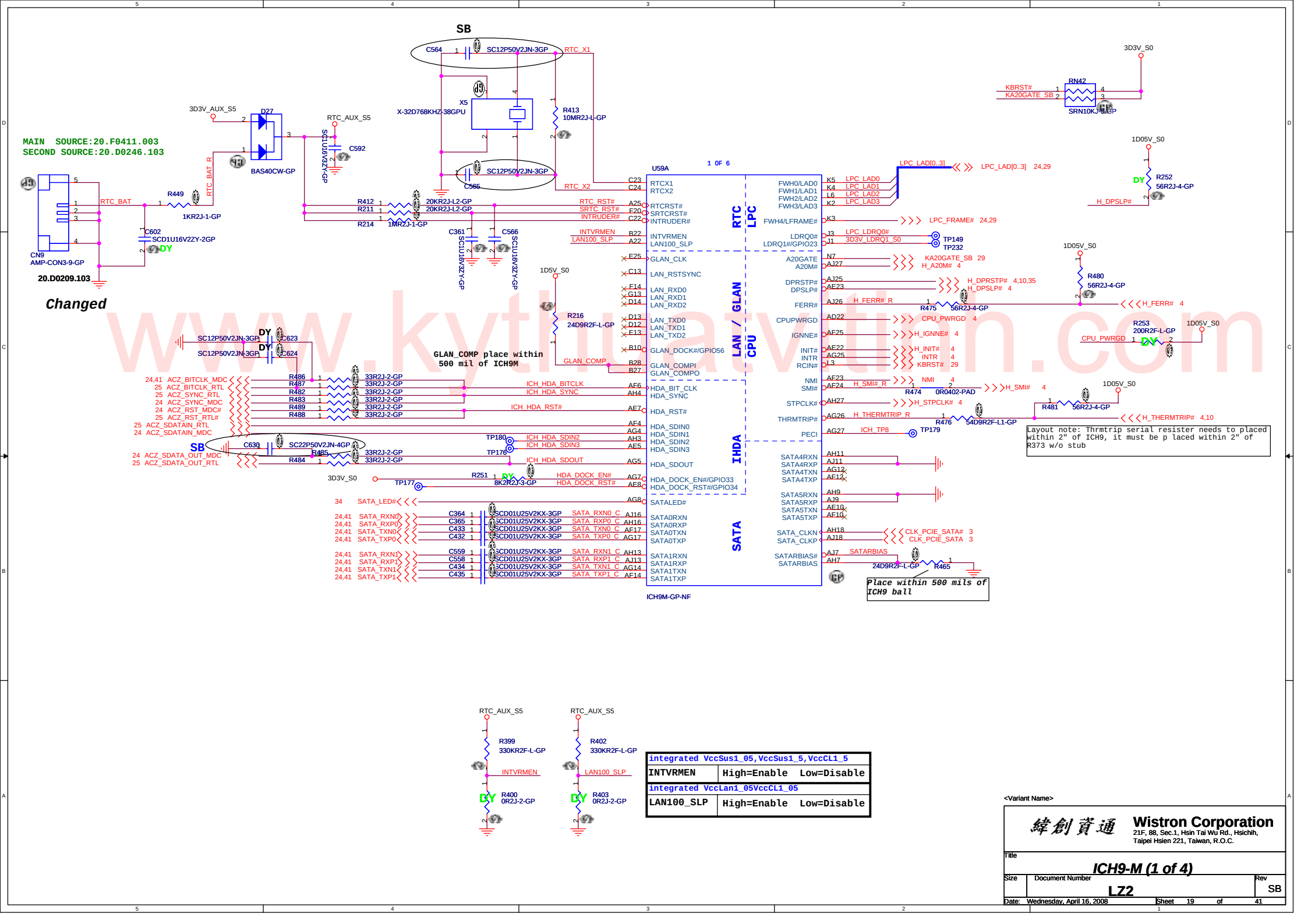
BOM1

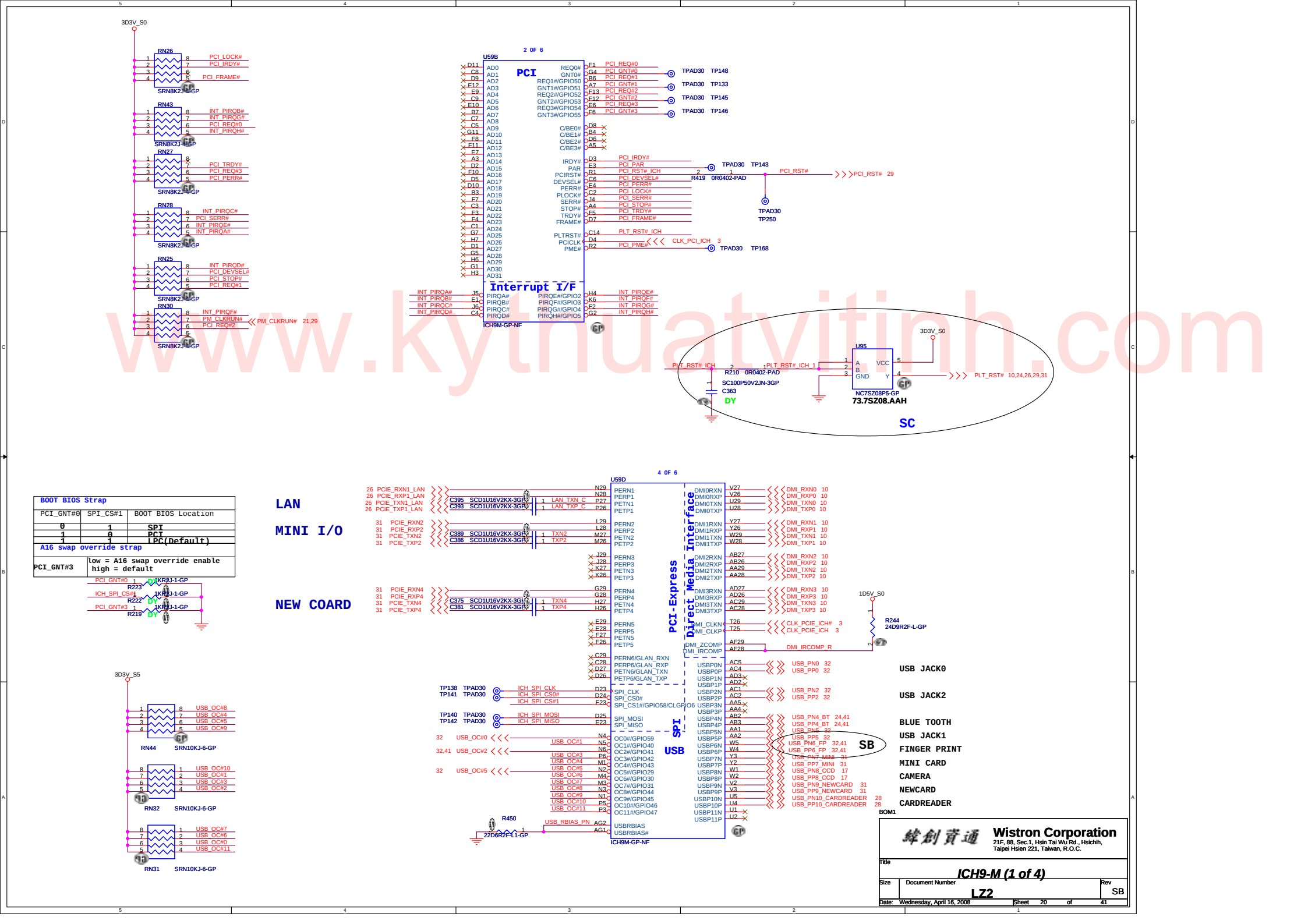
Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

Title	LCD CONN & CAMERA & DIG-MIC	
Size	Document Number: LZ2	Rev: SB
Date: Wednesday, April 16, 2008	Sheet 17 of 41	



Wistron Corporation	緯創資通
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih, Taipei Hsien 221, Taiwan, R.O.C.	
Title: CRT/TV Connector	
Size	Document Number: LZ2
Rev: SB	
Date: Wednesday, April 16, 2008	Sheet 18 of 41


SB
MAIN SOURCE:20.F0411.003
SECOND SOURCE:20.D0246.103
20.D0209.103
Changed
U59A
1 OF 6
ICH9M-GP-NF
RTC
LPC
GLAN / CPU
IHDA
SATA
GLAN_COMP place within 500 mil of ICH9M
Place within 500 mils of ICH9 ball
Layout note: Thrmtrip serial resister needs to placed within 2" of ICH9, it must be p laced within 2" of R373 w/o stub
integrated VccSus1_05,VccSus1_5,VccCL1_5
INTVRMEN High=Enable Low=Disable
integrated VccLan1_05VccCL1_05
LAN100_SLP High=Enable Low=Disable
Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih, Taipei Hsien 221, Taiwan, R.O.C.
ICH9-M (1 of 4)
LZ2
SB
Wednesday, April 16, 2008
19 of 41



BOOT BIOS Strap		
PCI_GNT#0	SPI_CS#1	BOOT BIOS Location
0	1	SPI
1	0	PCI
1	1	LPC(Default)
A16 swap override strap		
PCI_GNT#3	low = A16 swap override enable high = default	

LAN

MINI I/O

NEW COARD

USB JACK0

USB JACK2

BLUE TOOTH

USB JACK1

FINGER PRINT

MINI CARD

CAMERA

NEWCARD

CARDREADER

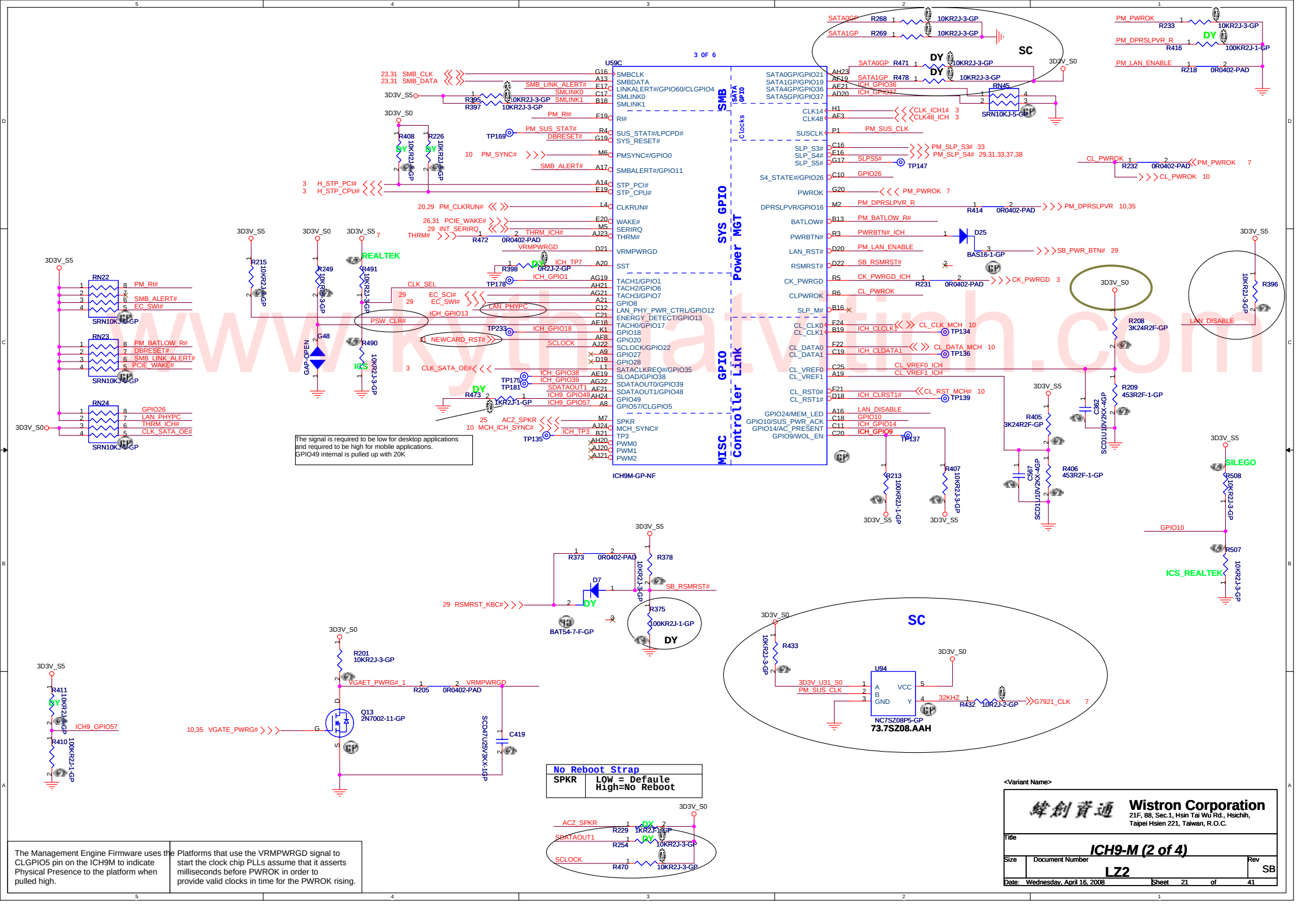
BOM1

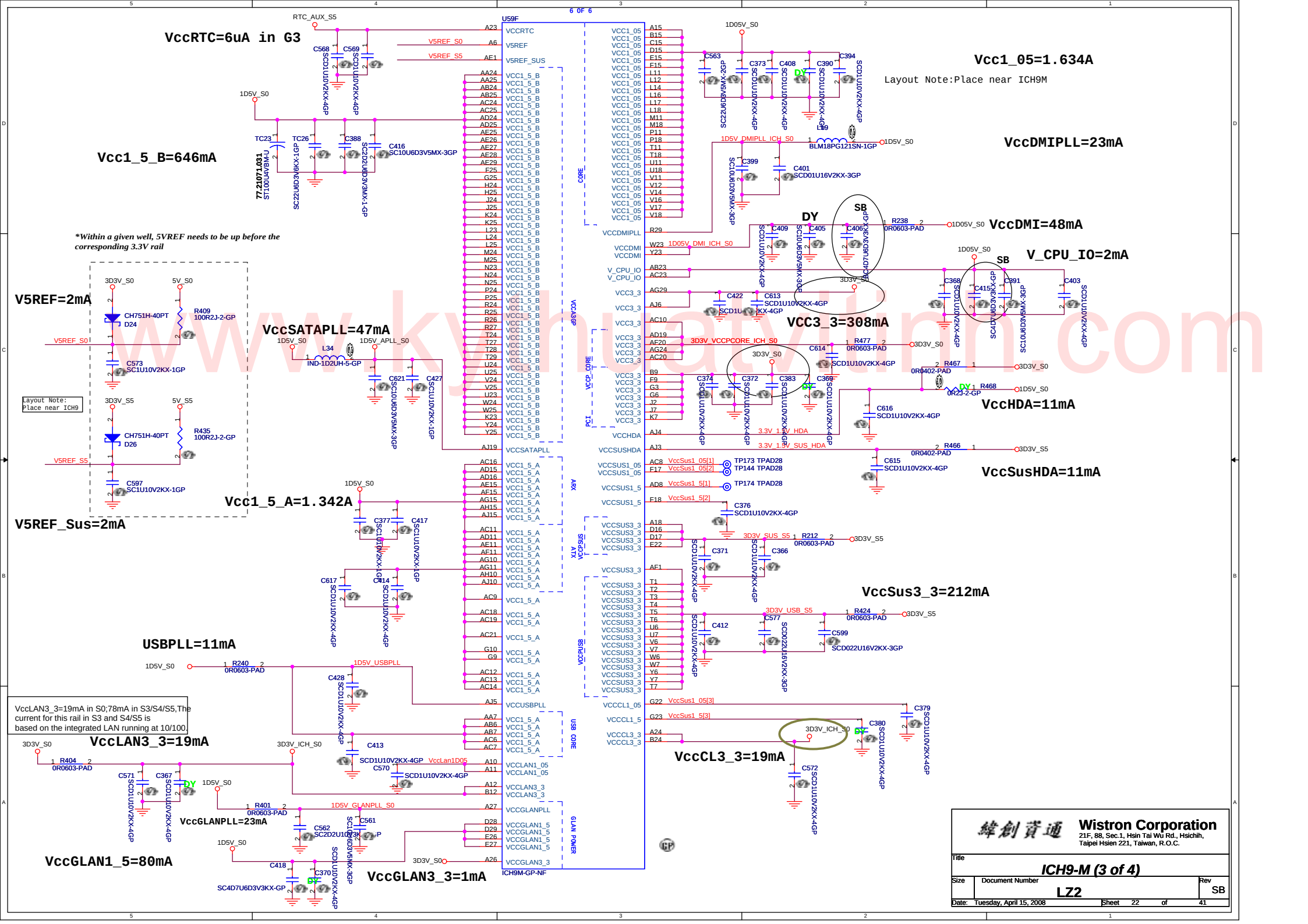
蜂創資通 **Wistron Corporation**
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

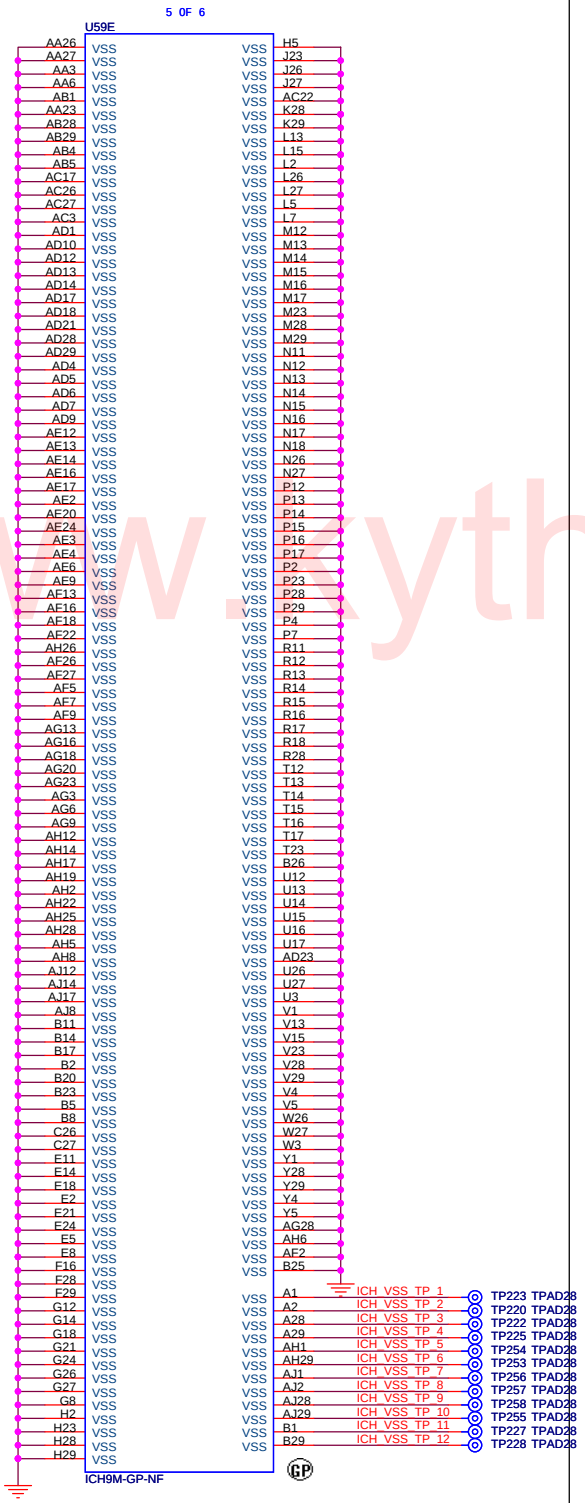
Title: *ICH9-M (1 of 4)*

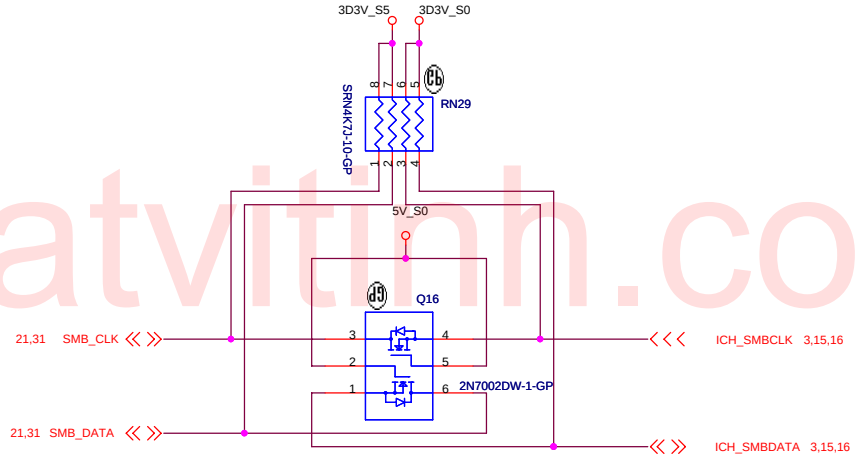
Size	Document Number	Rev
	LZ2	SB

Date: Wednesday, April 16, 2008 Sheet 20 of 41


U59C
3 OF 6
ICH9M-GP-NF
SMB
SATA GPIO
Clocks
SYS GPIO
Power MGT
GPIO
Controller Link
MISC
SC
REALTEK
ICS
SILEGO
GAP-OPEN
DY
No Reboot Strap
SPKR
LOW = Defaule
High=No Reboot
The signal is required to be low for desktop applications and required to be high for mobile applications. GPIO49 internal is pulled up with 20K
The Management Engine Firmware uses the CLGPIO5 pin on the ICH9M to indicate Physical Presence to the platform when pulled high.
Platforms that use the VRMPWRGD signal to start the clock chip PLLs assume that it asserts milliseconds before PWROK in order to provide valid clocks in time for the PWROK rising.
73.7SZ08.AAH
Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.
ICH9-M (2 of 4)
LZ2
SB
Wednesday, April 16, 2008
21 of 41


VccRTC=6uA in G3
Vcc1_5_B=646mA
Vcc1_05=1.634A
Layout Note:Place near ICH9M
VccDMIPLL=23mA
VccDMI=48mA
V_CPU_IO=2mA
VccHDA=11mA
VccSusHDA=11mA
VccSus3_3=212mA
VccCL3_3=19mA
VccGLANPLL=23mA
VccGLAN1_5=80mA
VccGLAN3_3=1mA
USBPLL=11mA
VccLAN3_3=19mA
VccLAN3_3=19mA in S0;78mA in S3/S4/S5,The current for this rail in S3 and S4/S5 is based on the integrated LAN running at 10/100.
V5REF=2mA
V5REF_Sus=2mA
VccSATAPLL=47mA
Vcc1_5_A=1.342A
VCC3_3=308mA
*Within a given well, 5VREF needs to be up before the corresponding 3.3V rail
Layout Note: Place near ICH9
U59F
6 OF 6
ICH9M-GP-NF
Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih, Taipei Hsien 221, Taiwan, R.O.C.
ICH9-M (3 of 4)
LZ2
SB
Tuesday, April 15, 2008
Sheet 22 of 41





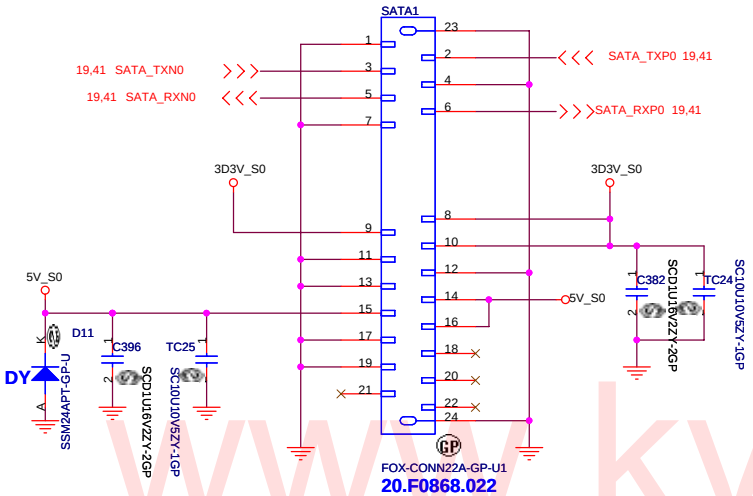
Q13 & Q14 connect SMLINK and SMBUS in S) for SMBus 2.0 compliance

SMBUS

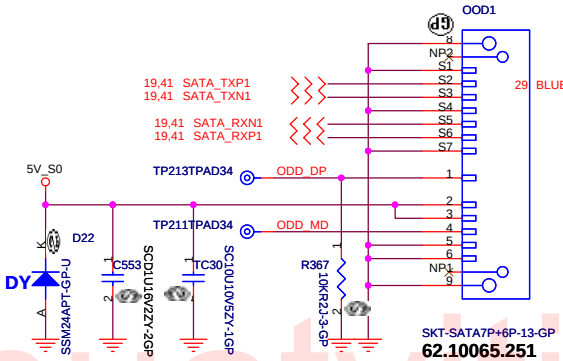
緯創資通 Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

Title	ICH9-M (4 of 4)	
Size	Document Number: LZ2	Rev: SB
Date: Wednesday, April 16, 2008	Sheet 23 of 41	

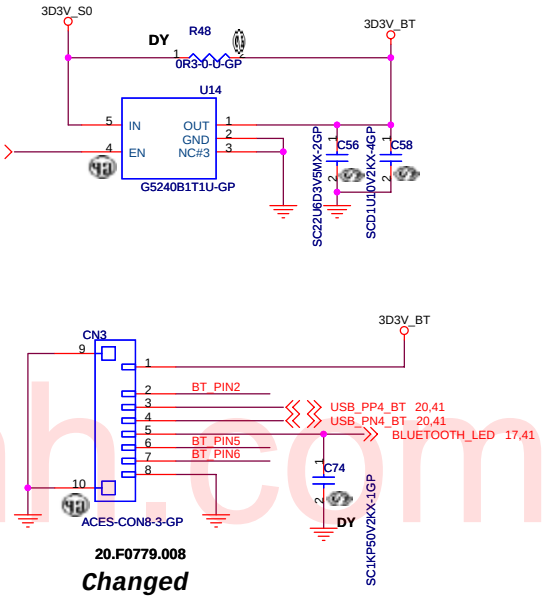
SATA HD Connector



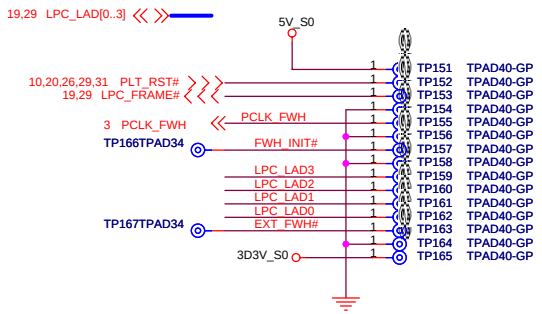
ODD Connector

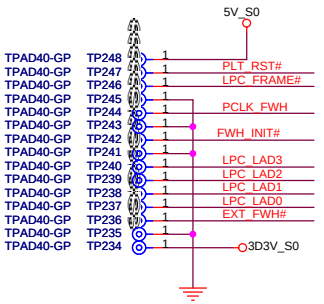


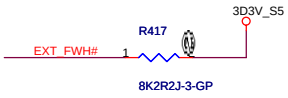
BT CONNECTOR



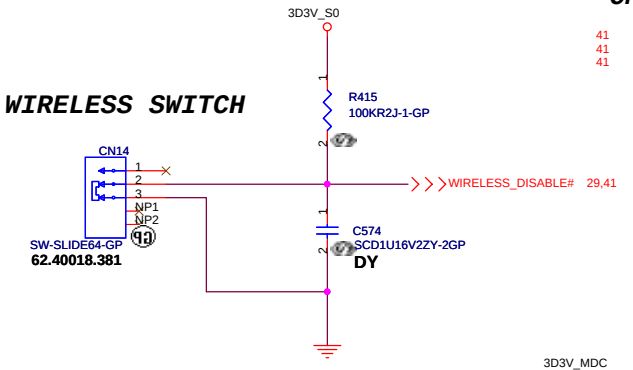
GOLDEN FINGER FOR DEBUG BOARD



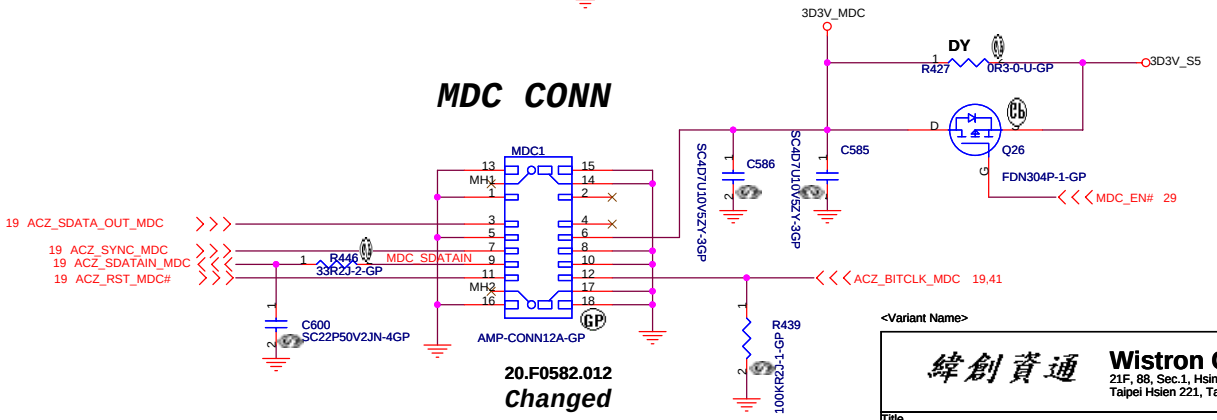




WIRELESS SWITCH



MDC CONN



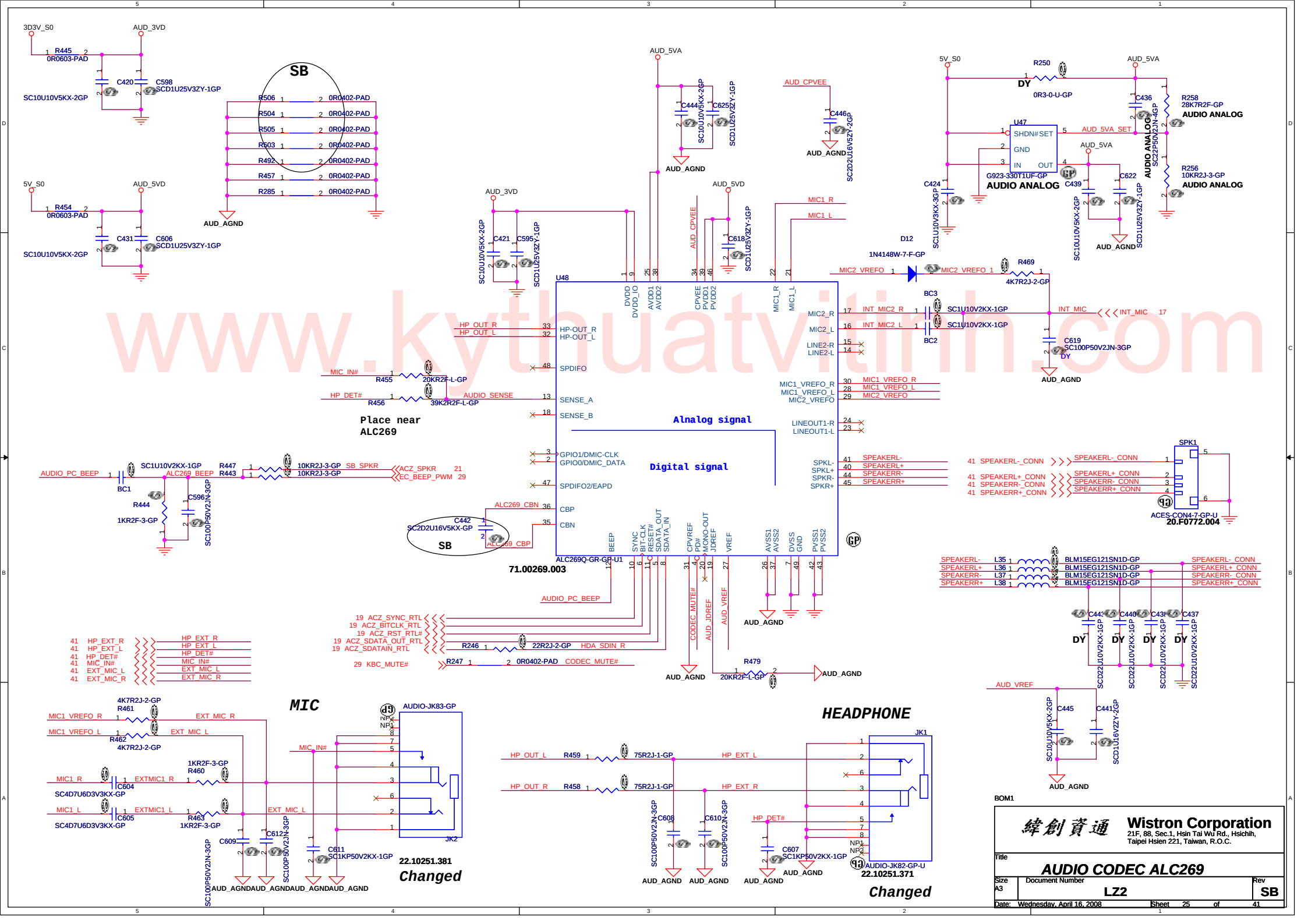
<Variant Name>

緯創資通 Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

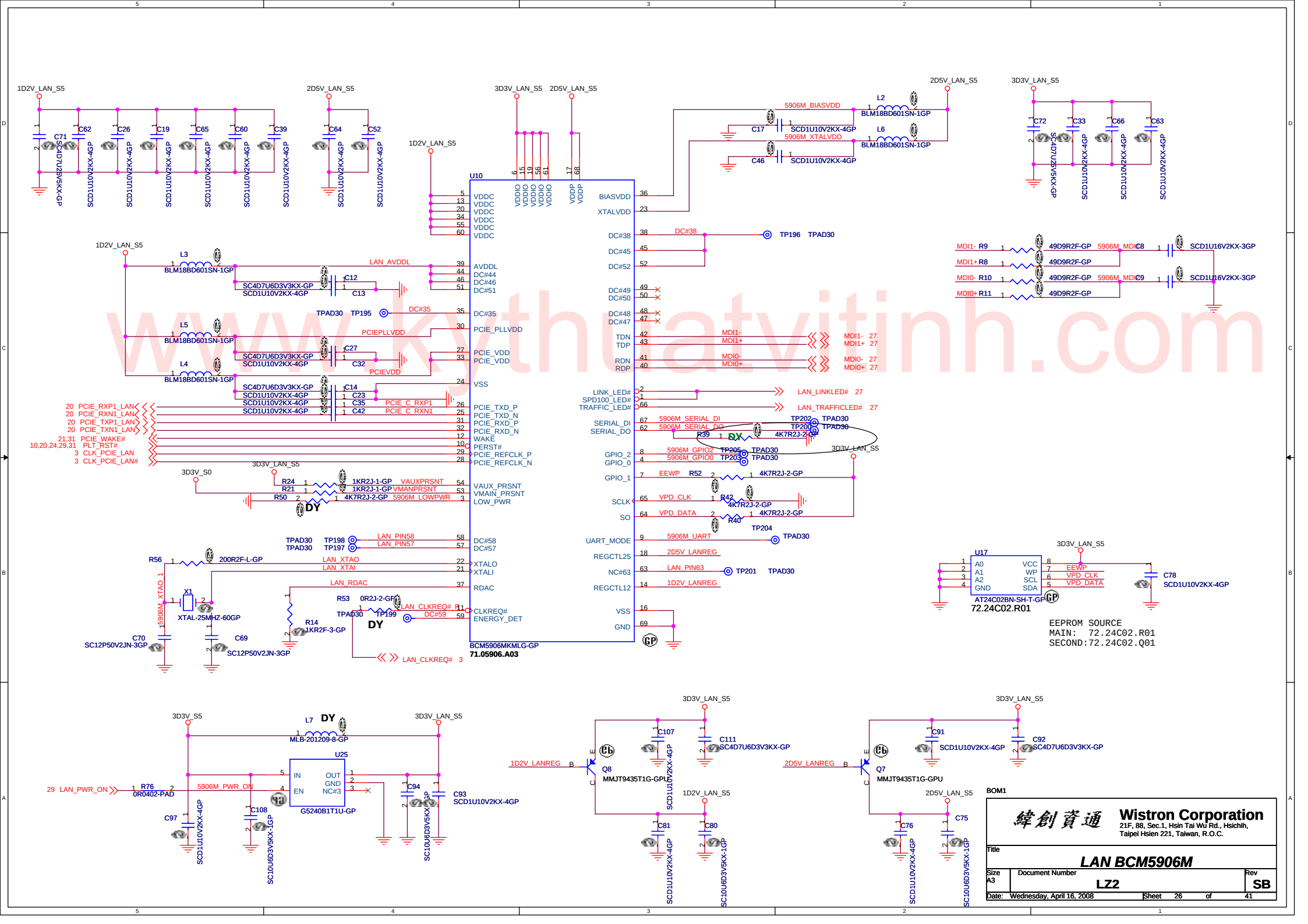
Title: HDD/CDROM/DEBUG /MODEM/WIRELESS SW/BT

Size	Document Number	Rev
	LZ2	SB

Date: Wednesday, April 16, 2008 Sheet 24 of 41

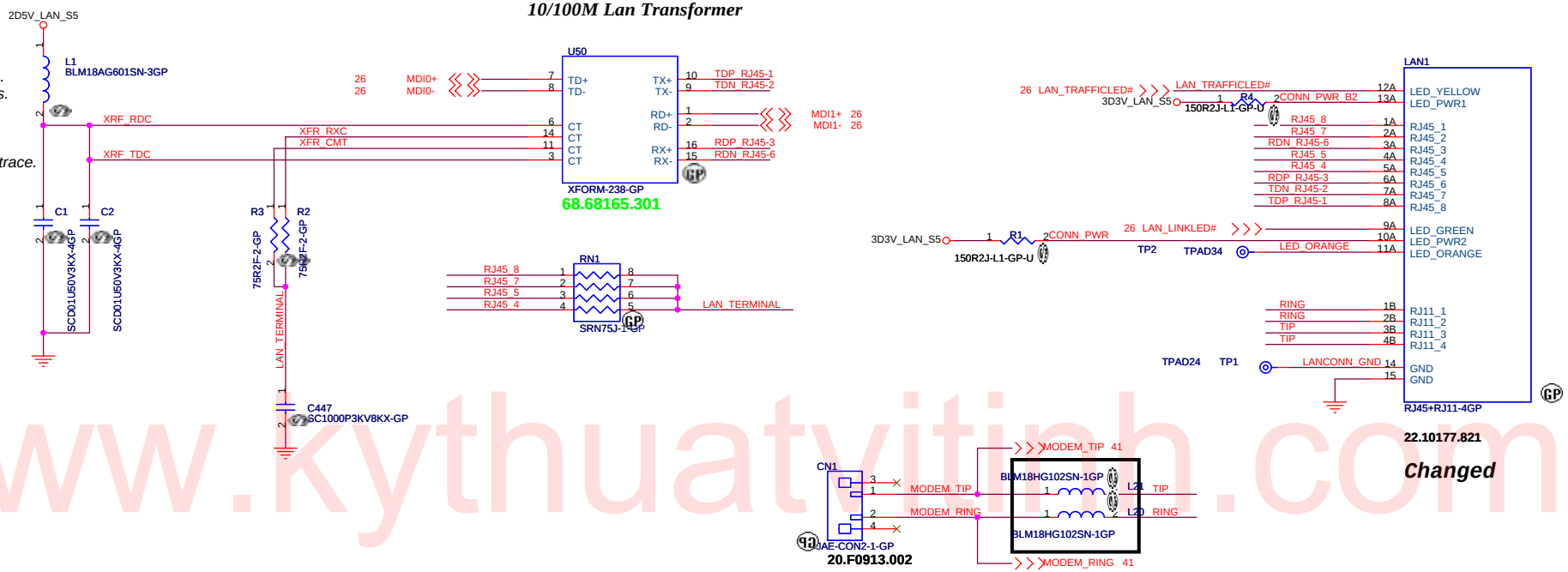


BOM1	
Wistron Corporation	21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih, Taipei Hsien 221, Taiwan, R.O.C.
Title	AUDIO CODEC ALC269
Size	A3
Document Number	LZ2
Rev	SB
Date:	Wednesday, April 16, 2008
Sheet	25 of 41



10/100M Lan Transformer

1.route on bottom as differential pairs.
2.Tx+/Tx- are pairs. Rx+/Rx- are pairs.
3.No vias, No 90 degree bends.
4.pairs must be equal lengths.
5.6mil trace width,12mil separation.
6.36mil between pairs and any other trace.
7.Must not cross ground moat,except RJ-45 moat.

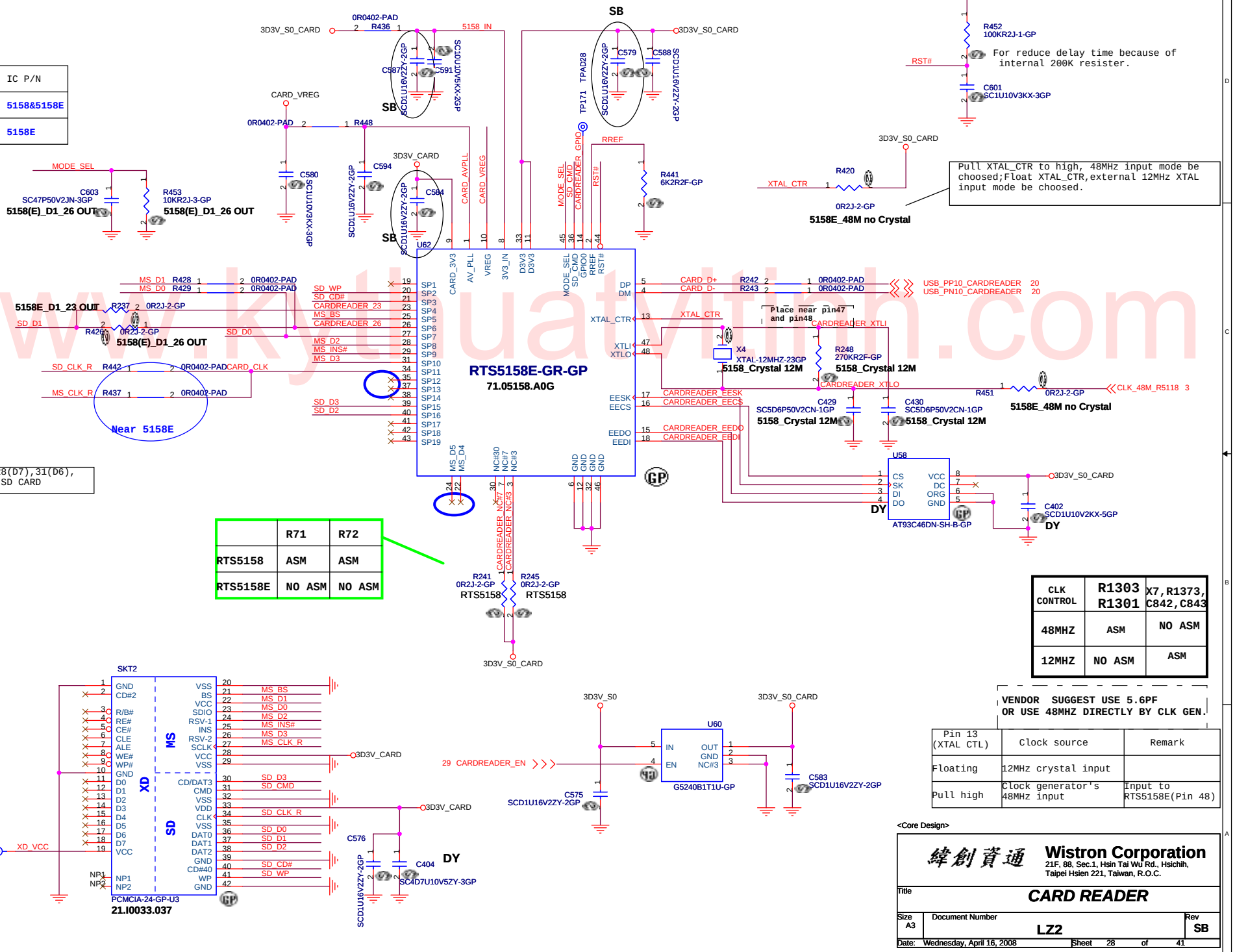


<Variant Name>

緯創資通	Wistron Corporation 21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih, Taipei Hsien 221, Taiwan, R.O.C.	
Title	LAN connector/NEW CARD/SIM	
Size A3	Document Number LZ2	Rev SB
Date: Wednesday, April 16, 2008	Sheet 27 of 41	

For 3in1 SD/MMC/MS CARD

R1302	C38	SD_D1 OUT FROM	IC P/N
10K	47 PF	PIN 26(MS_D1)	5158&5158E
NC	NC	PIN 23	5158E



*Vendor suggest: SD section--pin 28(D7),31(D6),
**35(D5),37(D4) RESERVED FOR 8PIN SD CARD

	R71	R72
RTS5158	ASM	ASM
RTS5158E	NO ASM	NO ASM

CLK CONTROL	R1303 R1301	X7,R1373, C842,C843
48MHZ	ASM	NO ASM
12MHZ	NO ASM	ASM

VENDOR SUGGEST USE 5.6PF
OR USE 48MHZ DIRECTLY BY CLK GEN.

Pin 13 (XTAL CTL)	Clock source	Remark
Floating	12MHz crystal input	
Pull high	Clock generator's 48MHz input	Input to RTS5158E(Pin 48)

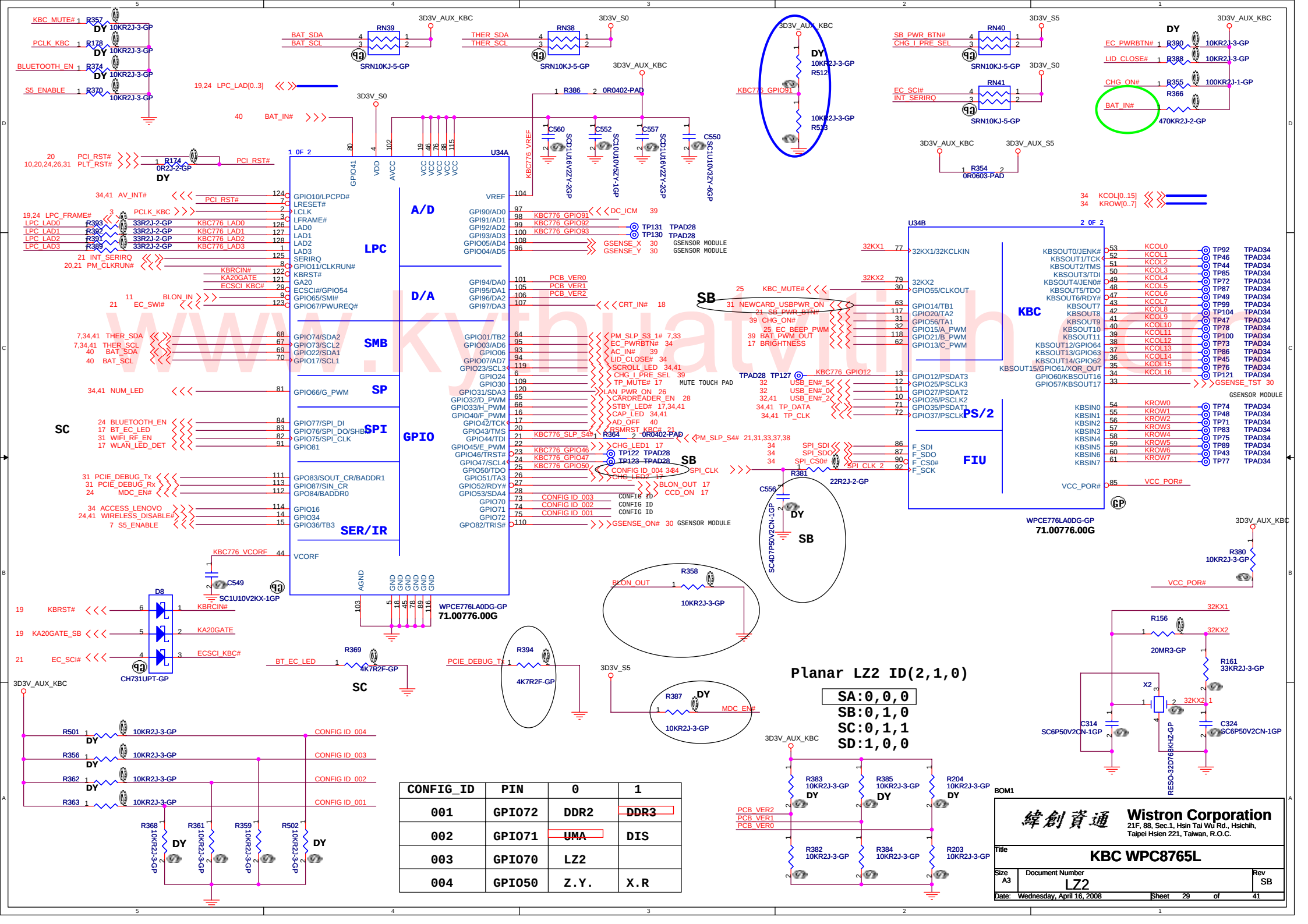
<Core Design>

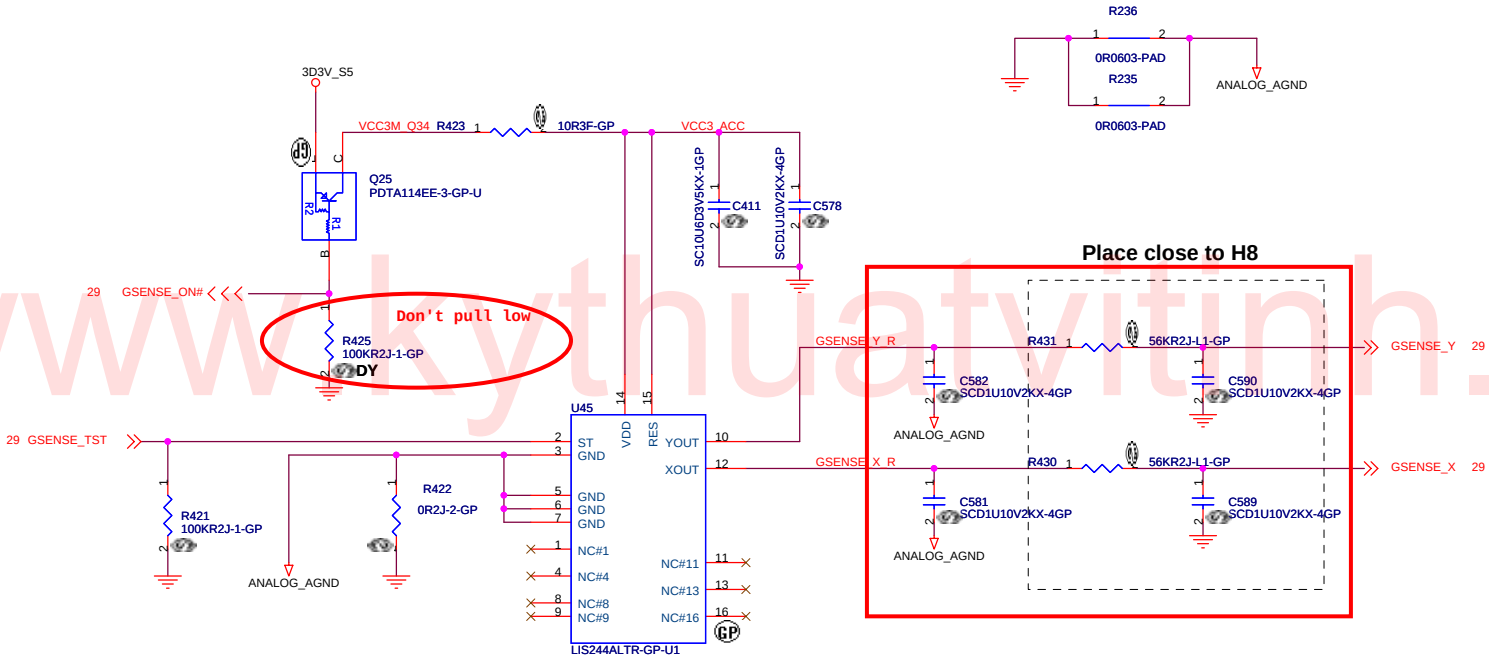
Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih, Taipei Hsien 221, Taiwan, R.O.C.

Title: CARD READER

Size: A3 | Document Number: LZ2 | Rev: SB

Date: Wednesday, April 16, 2008 | Sheet 28 of 41


U34A
1 0F 2
WPCE776LA0DG-GP
71.00776.00G
A/D
LPC
D/A
SMB
SP
SPI
GPIO
SER/IR
SB
SC
U34B
2 0F 2
KBC
PS/2
FIU
WPCE776LA0DG-GP
71.00776.00G
Planar LZ2 ID(2,1,0)
SA:0,0,0
SB:0,1,0
SC:0,1,1
SD:1,0,0
CONFIG_ID | PIN | 0 | 1
001 | GPIO72 | DDR2 | DDR3
002 | GPIO71 | UMA | DIS
003 | GPIO70 | LZ2 |
004 | GPIO50 | Z.Y. | X.R
Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.
KBC WPC8765L
Size A3
Document Number LZ2
Rev SB
Date: Wednesday, April 16, 2008
Sheet 29 of 41



Primary : STMicro LIS244AL
2nd: ADI ADXL322

Width = 6 mil & Spacing = 10 mil for three Output traces

	ADXL322 LIS244AL	No Accel
R545	NO_ASM	ASM
R547	ASM	ASM
All other	ASM	NO_ASM

Layout Comment :

(1) Place C148, C149, Q18, R116, R121, C126, C130, R107, R106 close to U18.

(2) Avoid routing under DCDC switching area.

BOM1

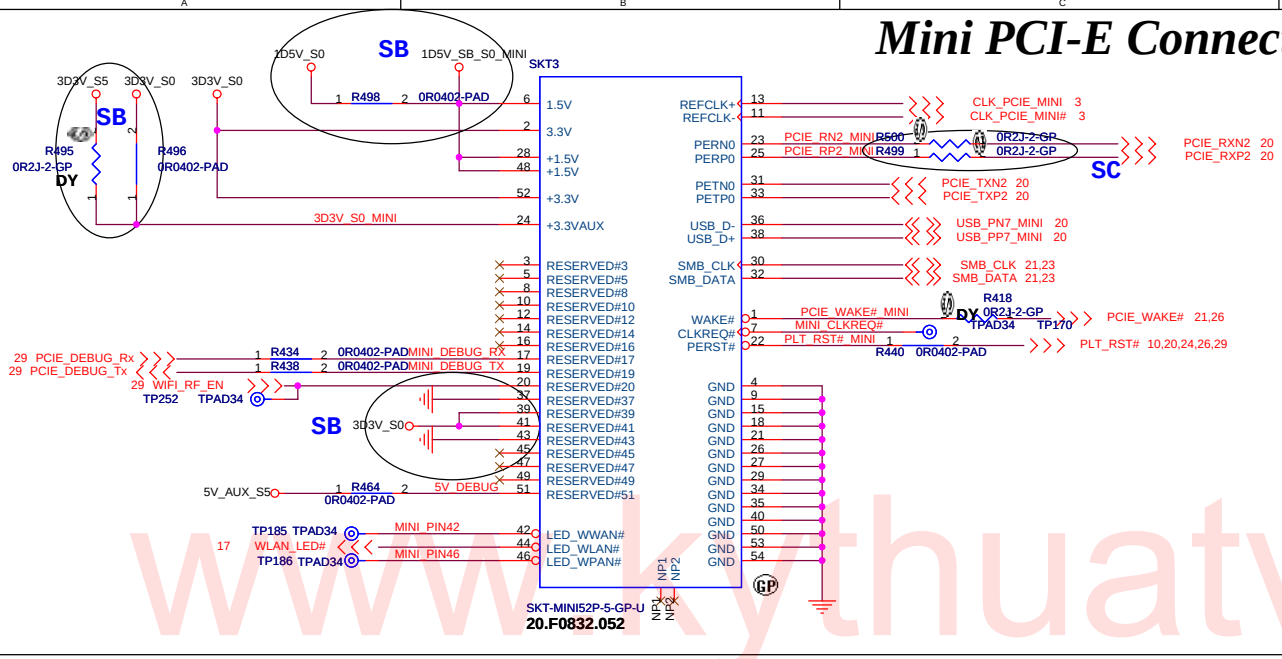
緯創資通 **Wistron Corporation**
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

Title: **GSENSOR**

Size	Document Number	Rev
	LZ2	SB

Date: Wednesday, April 16, 2008 Sheet 30 of 41

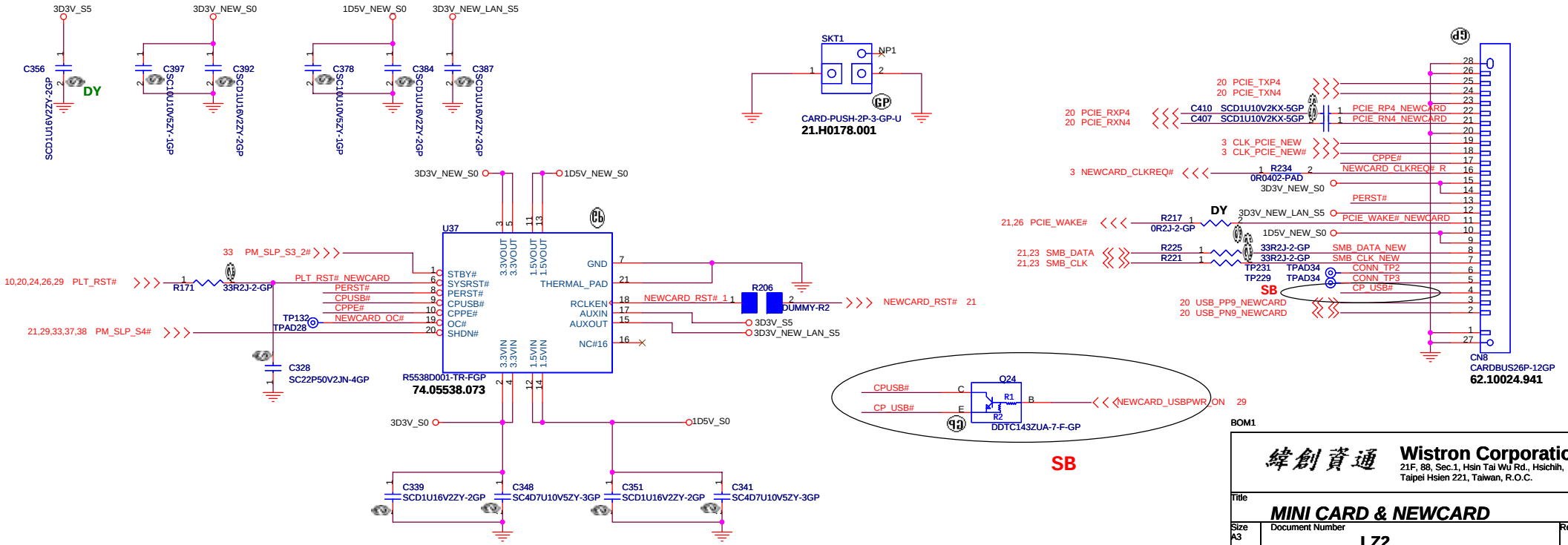
Mini PCI-E Connector



Place them Near to Chip

Place them Near to Connector

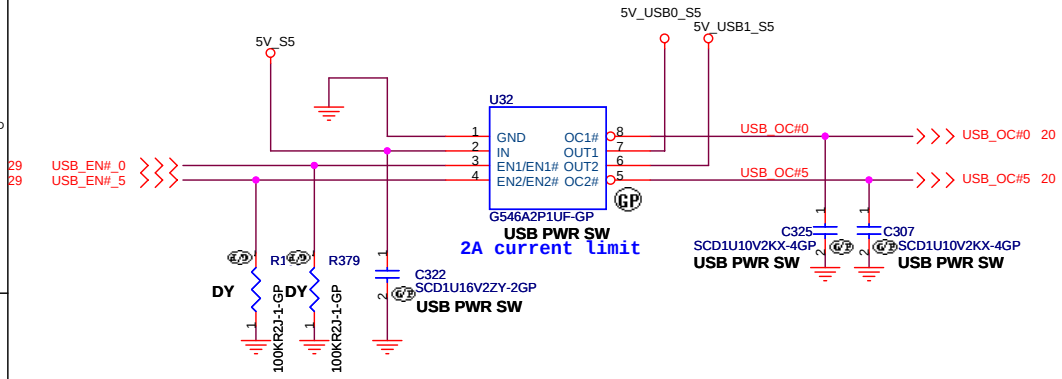
.N.E.W.C.A.R.D. C.O.N.N.

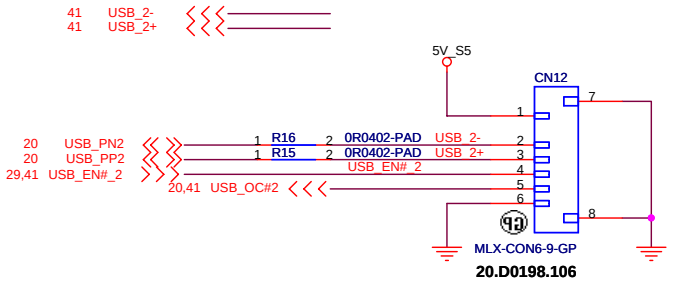


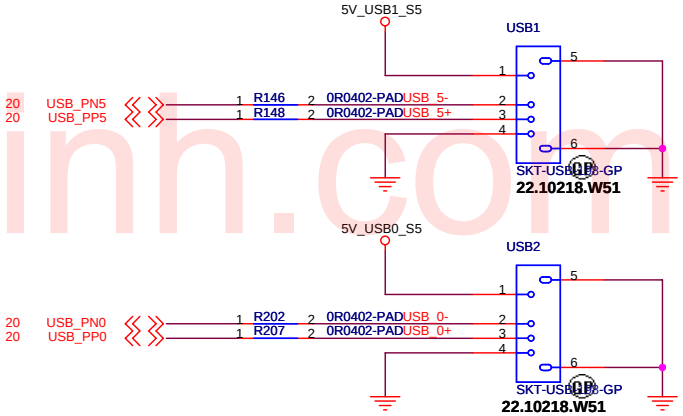
BOM1

緯創資通	**Wistron Corporation** 21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih, Taipei Hsien 221, Taiwan, R.O.C.	
Title	***MINI CARD & NEWCARD***	
Size A3	Document Number **LZ2**	Rev **SB**
Date: Wednesday, April 16, 2008	Sheet 31 of 41	

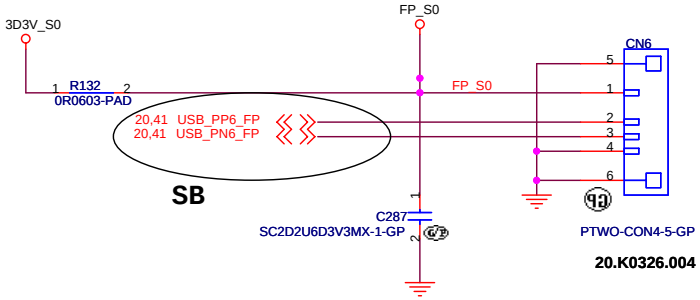
USB * 3 PORT

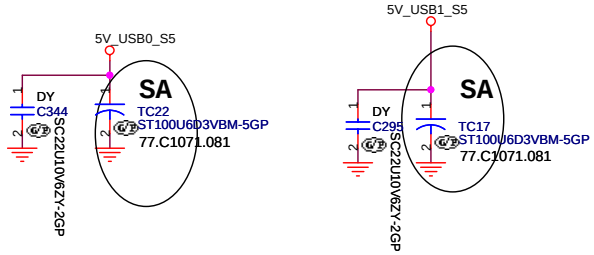


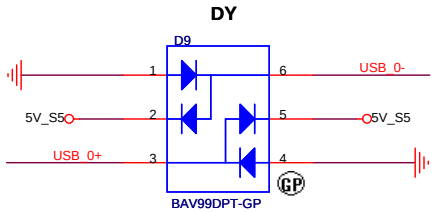


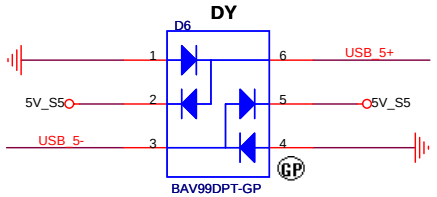


Finger Print









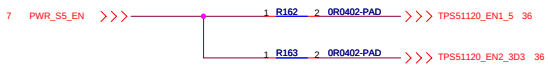
BOM1

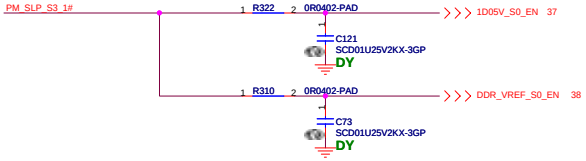
緯創資通 **Wistron Corporation**
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

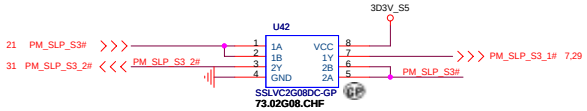
Title: **USB CONN/FINGER PRINT**

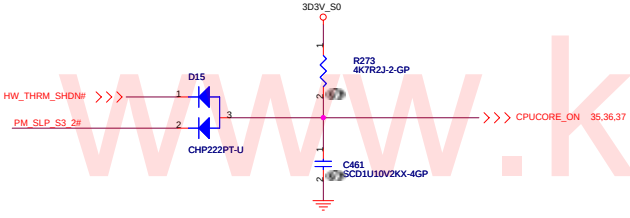
Size	Document Number	Rev
B	LZ2	SB

Date: Wednesday, April 16, 2008 Sheet 32 of 41

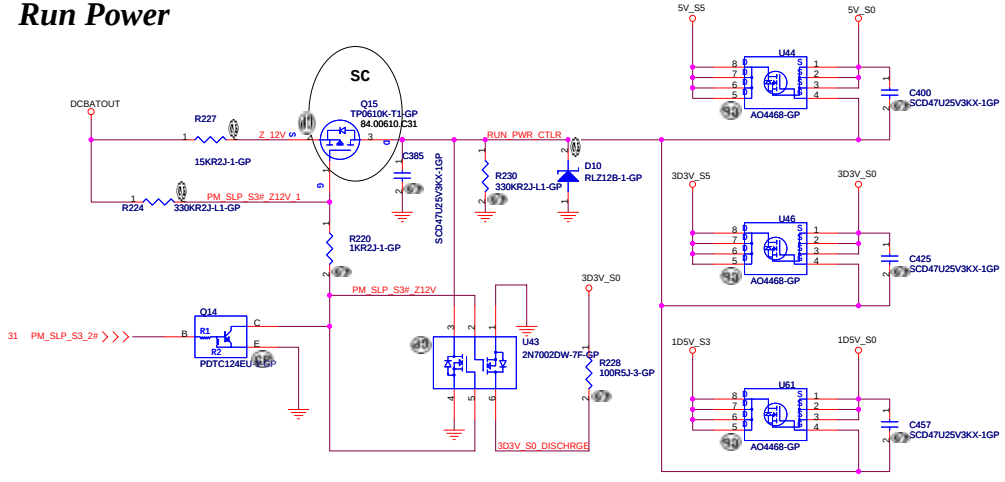


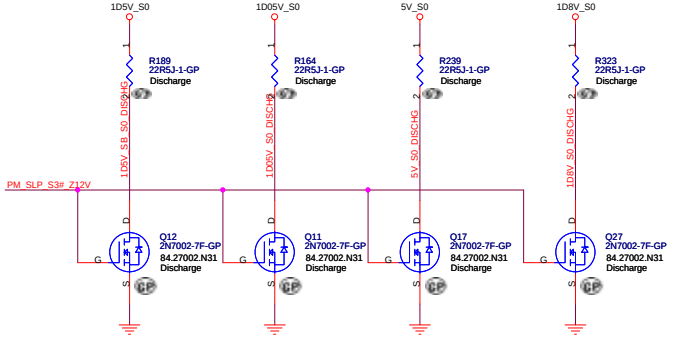


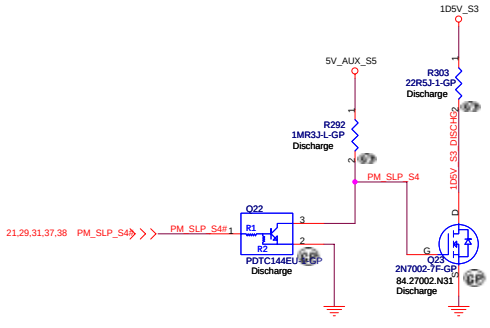




Run Power







BOM1

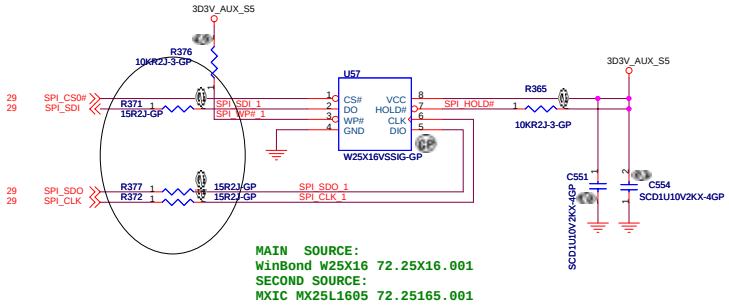
蜂創資通 **Wistron Corporation**
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

Title: ***PWRPLANE&RESET LOGIC***

Size	Document Number	Rev
	LZ2	SB

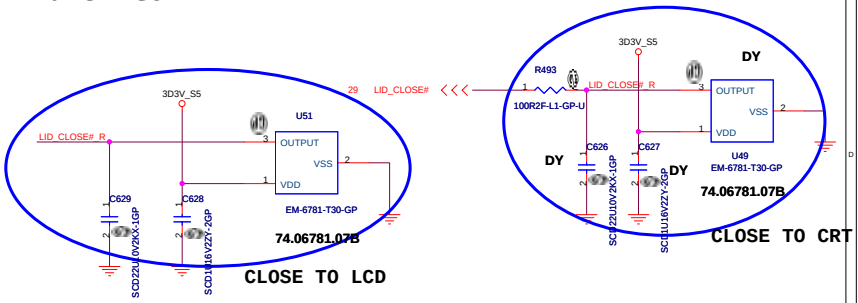
Date: Wednesday, April 16, 2008 Sheet 33 of 41

SPI Flash

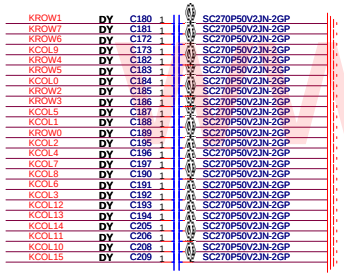


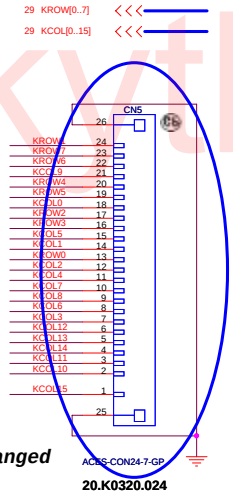
MAIN SOURCE:
WinBond W25X16 72.25X16.001
SECOND SOURCE:
MXIC MX25L1605 72.25165.001

Lid Switch



Keyboard Connector

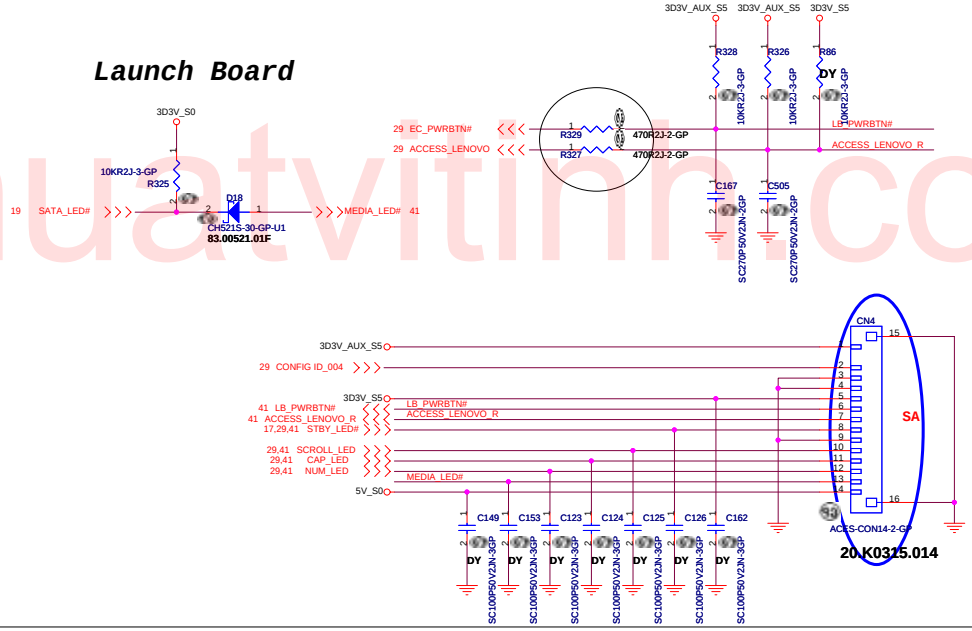




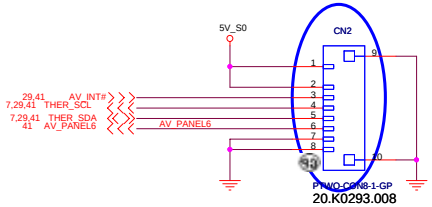
Changed

20.K0320.024

Launch Board

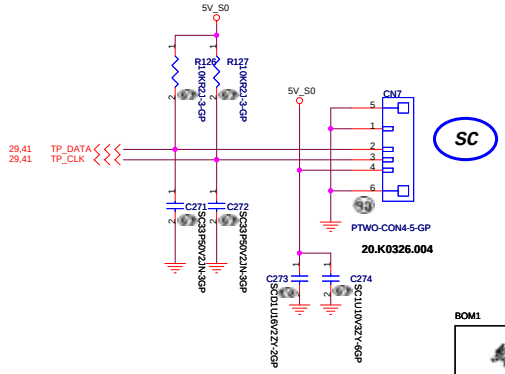


AV Panel



20.K0293.008

TouchPad Connector



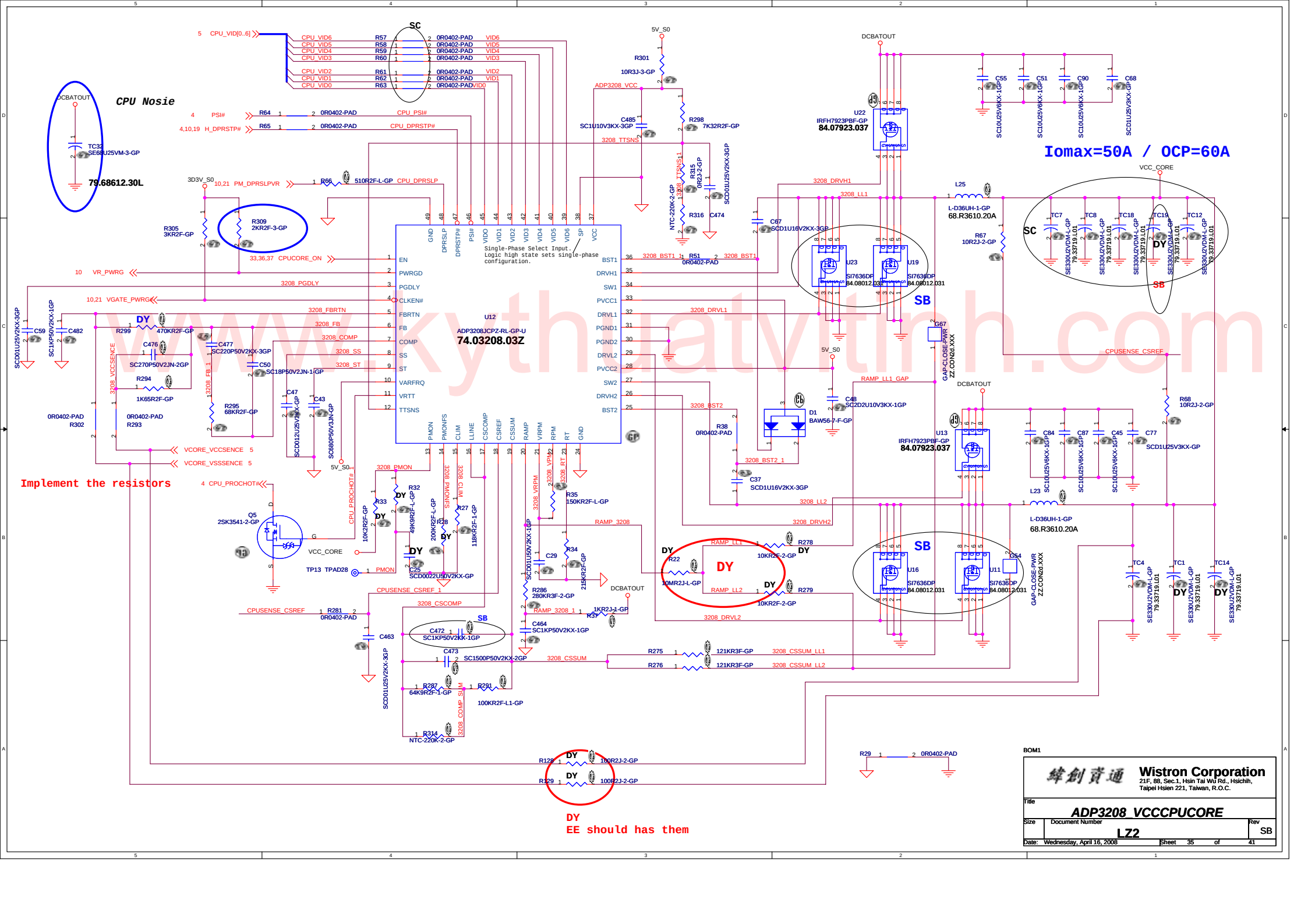
BOM1

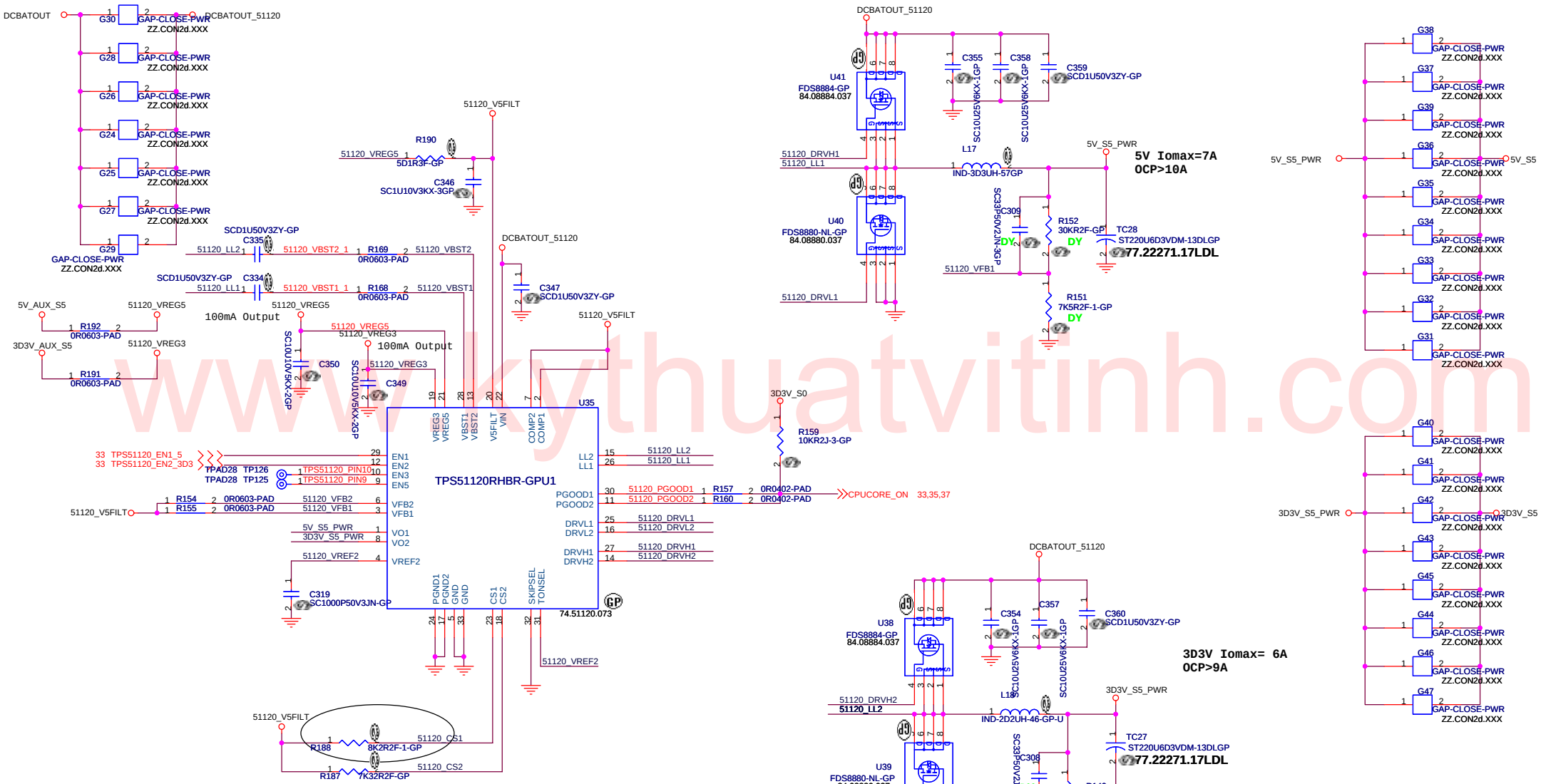
Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

Title: KB/TP/SPI/AV/Charger

Size	Document Number	Rev
	LZ2	SB

Date: Wednesday, April 16, 2008 Sheet 34 of 41


CPU Nosie
79.68612.30L
ADP3208J-RL-GP-U
74.03208.03Z
Iomax=50A / OCP=60A
Implement the resistors
DY
EE should has them
SB
SC
Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.
ADP3208_VCCCPUCORE
LZ2
Wednesday, April 16, 2008



	GND	VREF2	FLOAT	V5FILT
SKIPSEL	AUTOSKIP	AUTOSKIP /FAULTS OFF	PWM	PWM
	N/A	N/A	CURRENT MODE	D-Cap MODE
	380k/CH1 590k/CH2	280k/CH1 430k/CH2	220k/CH1 330k/CH2	180k/CH1 280k/CH2
	N/A	not use	ADJ.	5V Fixed Output
	N/A	not use	ADJ.	3.3V Fixed Output
	Switcher OFF	not use	Swithchr ON	Switcher ON
	LDO OFF	not use	LDO ON	VREG3 on

For TPS51120,
Vout=5V
1. If you use a 6.8uH inductor, the minimum ESR is 70m ohm.
2. If you use a 4.7uH inductor, the minimum ESR is 48m ohm.
3. If you use a 3.3uH inductor, the minimum ESR is 34m ohm.
Vout=3.3V
1. If you use a 4.7uH inductor, the minimum ESR is 51m ohm.
2. If you use a 3.3uH inductor, the minimum ESR is 36m ohm.
3. If you use a 2.5uH inductor, the minimum ESR is 27m ohm.

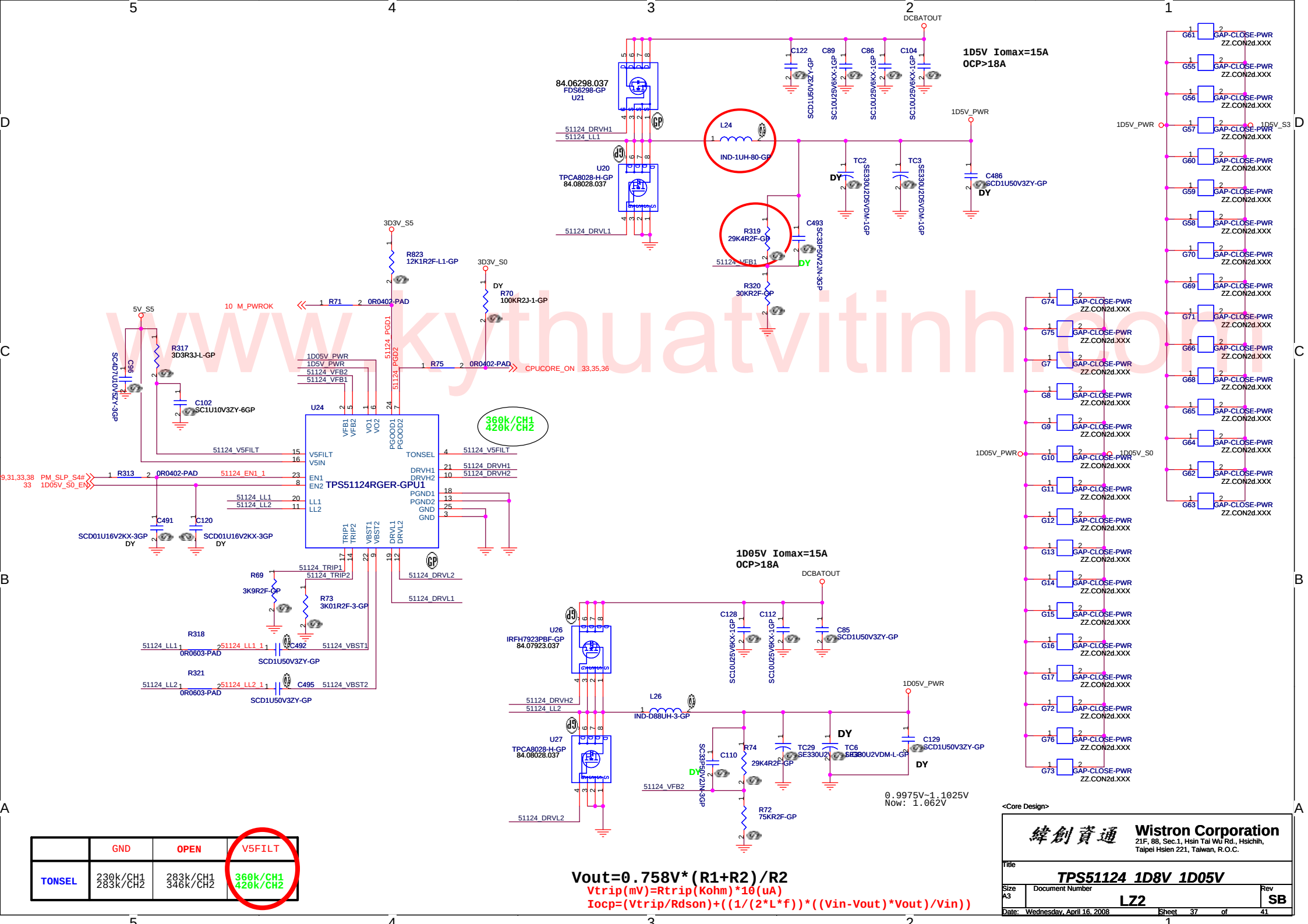
<Core Design>

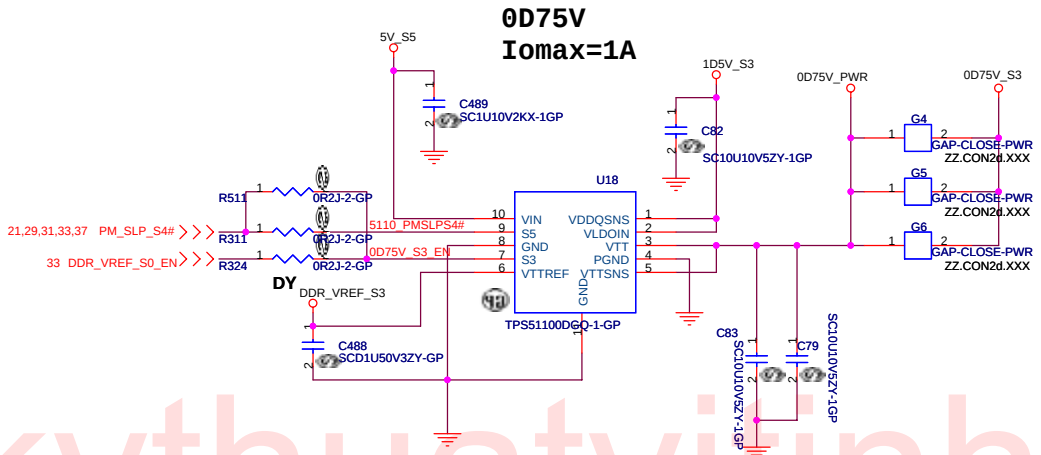
緯創資通 Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

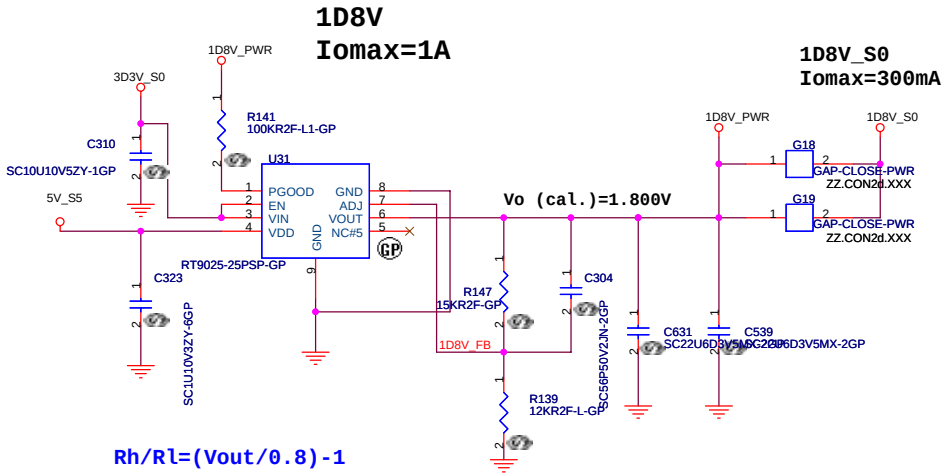
Title: TPS51120 5V / 3D3V

Size	Document Number	Rev
A3	LZ2	SB

Date: Wednesday, April 16, 2008 Sheet 36 of 41







<Core Design>

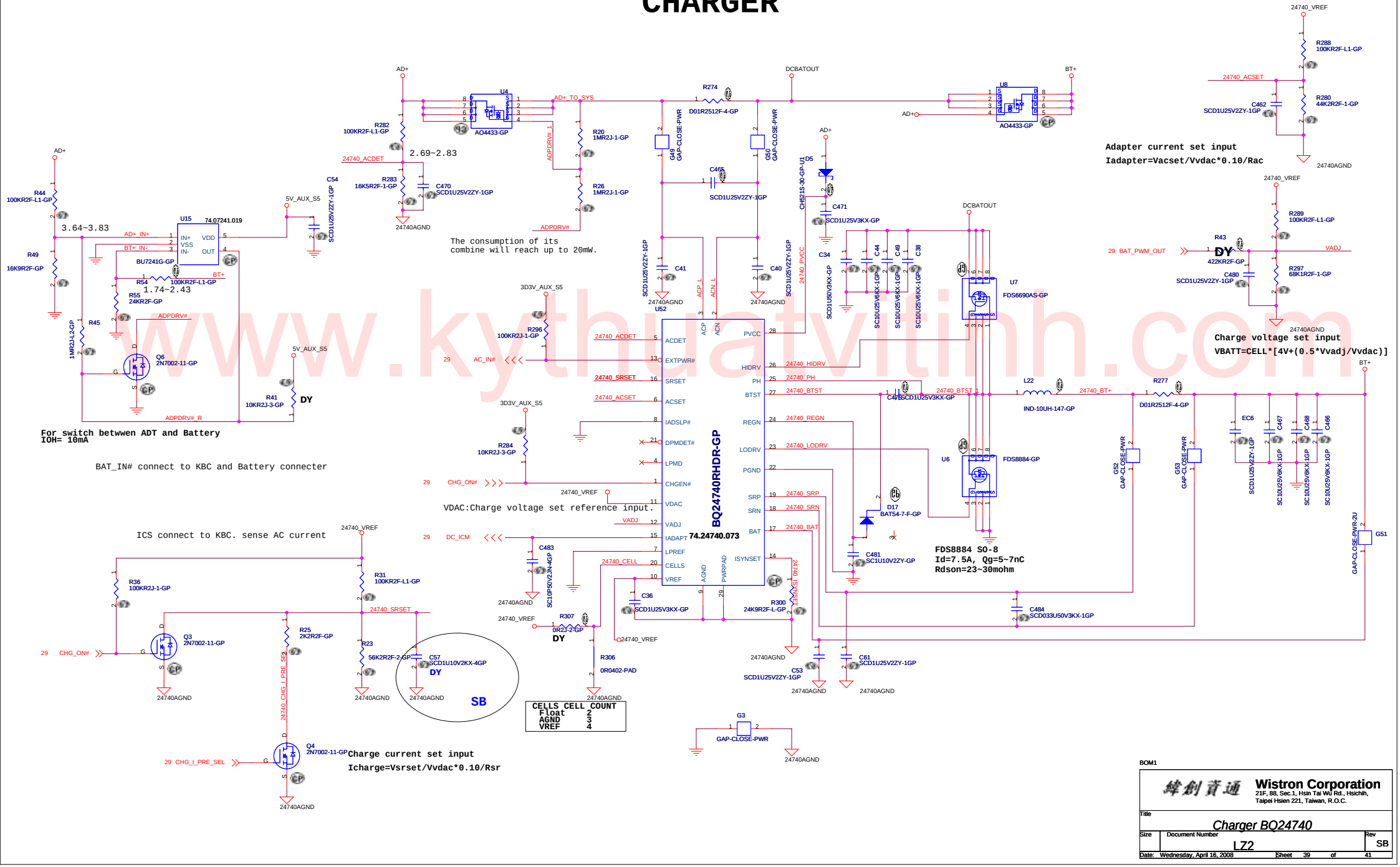
緯創資通 Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

Title: LDO 0D9V / 1D5V_S0

Size: A3 | Document Number: LZ2 | Rev: SB

Date: Wednesday, April 16, 2008 | Sheet 38 of 41

CHARGER



BOM1

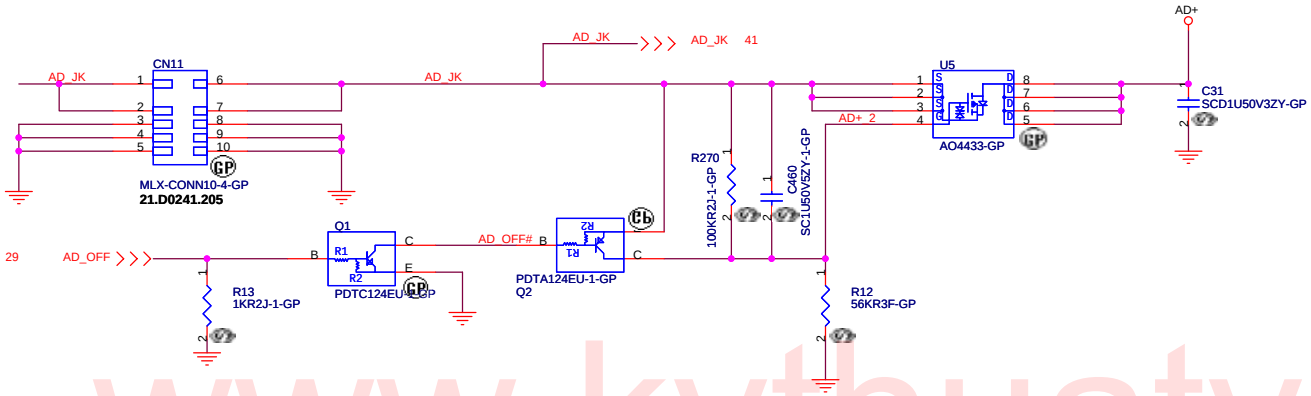
Wistron Corporation
21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

Title: Charger BQ24740

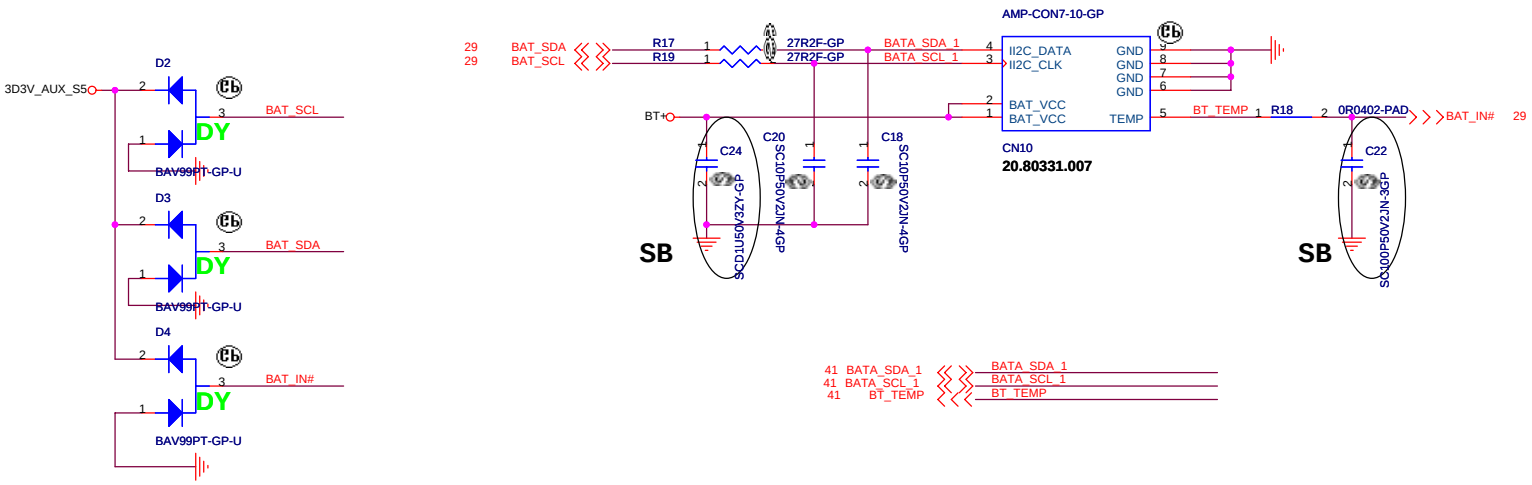
Size	Document Number	Rev
	LZ2	SB

Date: Wednesday, April 16, 2008 Sheet 39 of 41

Adaptor in to generate DCBATOUT

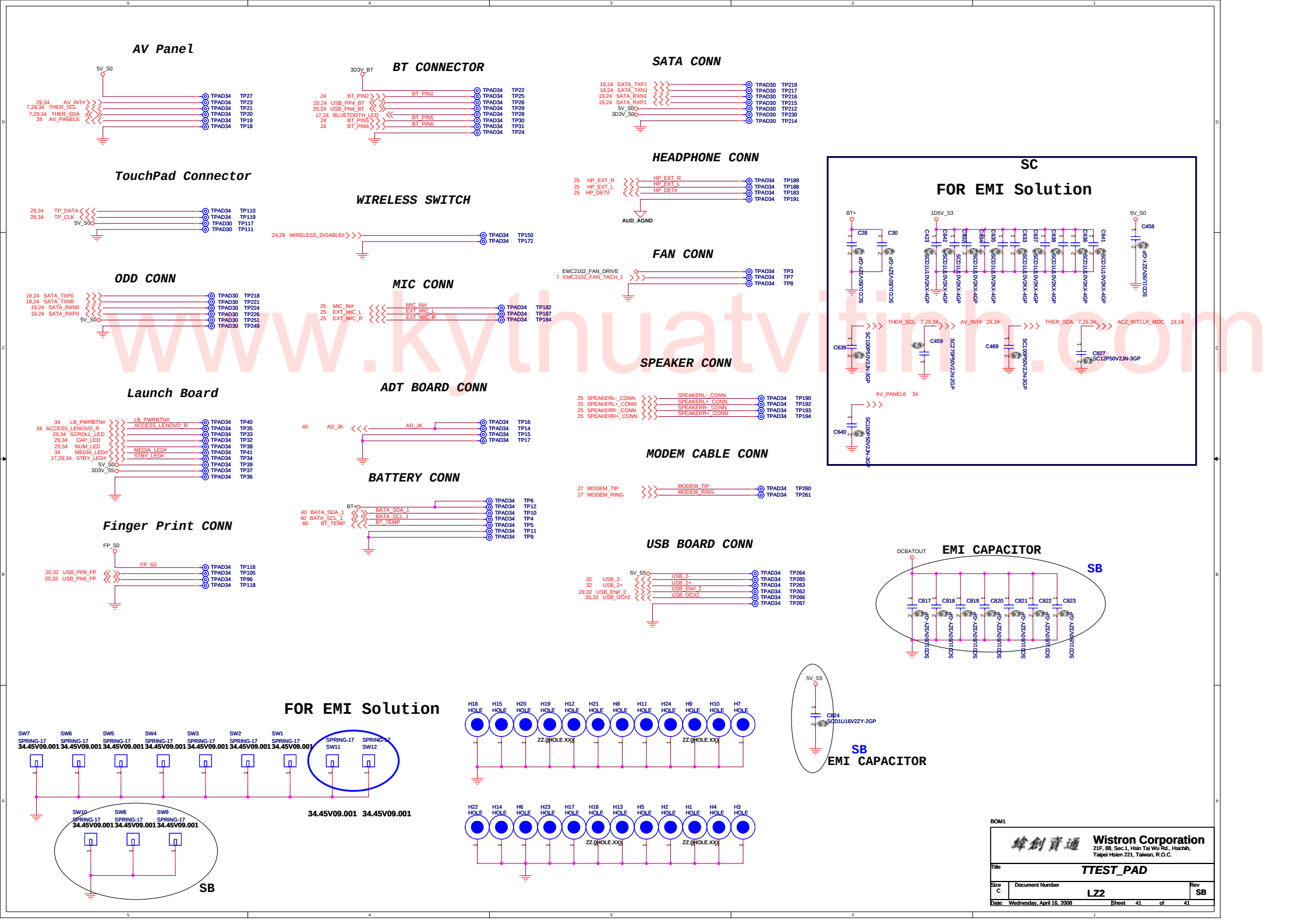


BATTERY CONNECTOR



<Core Design>

緯創資通 Wistron Corporation	21F, 88, Sec.1, Hsin Tai Wu Rd., Hsichih, Taipei Hsien 221, Taiwan, R.O.C.
Title	PTH FOR SCREW HOLES
Size A3 / Document Number	LZ2 / Rev SB
Date: Wednesday, April 16, 2008	Sheet 40 of 41


AV Panel
BT CONNECTOR
SATA CONN
TouchPad Connector
WIRELESS SWITCH
HEADPHONE CONN
SC
FOR EMI Solution
ODD CONN
MIC CONN
FAN CONN
Launch Board
ADT BOARD CONN
SPEAKER CONN
BATTERY CONN
MODEM CABLE CONN
Finger Print CONN
USB BOARD CONN
EMI CAPACITOR
SB
FOR EMI Solution
SB
EMI CAPACITOR
www.kythuatvitinh.com
Wistron Corporation
TTEST_PAD
LZ2